## 23V Buck－Boost Converter with Integrated MOSFETs

## GENERAL DESCRIPTION

## BENEFITS and FEATURES

－Buck－Boost Converter with 4 Integrated Switches
－Wide VIN Range：3．9V to 23V（No Dead Zone）
－Wide VOUT Range：3．0V to 23V
－Supports QC3．0／USB PD＋PPS output levels and transition times
－Programmable Frequency： $125 \mathrm{KHz}, 250 \mathrm{KHz}$ ， 500 kHz ，and 1 MHz
－2V～5．1V／100mA Programmable Output LDO
－Precision 0．5\％Voltage Reference
－＋／－4\％Output Constant Current Regulation
－Programmable Output Voltage and Currents via both IC pins and $I^{2} C$
－Programmable Soft－Start
－Programmable Safety Timer
－Cycle－by－Cycle Current Limit
－Built in ADC for Temperature，Input and Output Voltage and Current monitoring
－Thermal Regulation and Protection
－25m $\Omega$ FET from VIN to SW1
－25m』 FET from SW2 to VOUT
－ 35 m の FET from SW1 to PGND
－35m』 FET from SW2 to PGND
－Thermally Enhanced 32－Lead 4mx4mm QFN

## APPLICATIONS

－Car Charger
－Power Bank
－24V Industrial Applications
－Automotive Power Systems
－Multiple Power Source Supplies
－DC UPS
－Solar Powered Devices
－Solid－State Lighting

The ACT510x is a buck－boost converter with 4 inte－ grated MOSFETs．It offers a high efficiency，low com－ ponent count，compact solution for a wide input voltage： 3.9 V to 23 V

The 4 internal low resistance NMOS switches minimize the size of the application circuit and reduce power losses to maximize efficiency．Internal high side gate drivers，which require only the addition of two small ex－ ternal capacitors，further simplify the design process．An advanced switch control algorithm allows the buck－ boost converter to maintain output voltage regulation with input voltages that are above，below or equal to the output voltage．Transitions between these operating modes are seamless and free of transients and subhar－ monic switching．

The ACT510x has been optimized to reduce input cur－ rent in shipping，shutdown，and standby for applications which are sensitive to quiescent current draw，such as battery－powered devices．

The ACT510x output voltage can be set between $3 \mathrm{~V} \sim$ 23 V which can be configured by either $\mathrm{I}^{2} \mathrm{C}$（ACT5101） or an external resistor divider（ACT5102）．The output constant current limit and cord compensation makes it flexible for any kinds of protocols such as USB PD，QC 3．0／4．0 etc．The system can be monitored and config－ ured by $\mathrm{I}^{2} \mathrm{C}$ as well．The build－in ADC can be read for the information of input／output voltages and currents， and the die temperature．

ACT510x integrates a 100mA LDO with OCP／UVLO protection to provide power for the MCU and other pe－ ripheral components inside the system．

The ACT510x operation frequency can be configured from 125 kHz to 1 MHz ，making the system design flex－ ible for components size and efficiency optimization．

The ACT510x has been optimized to reduce input cur－ rent for applications which are sensitive to quiescent current draw，such as battery－powered devices．
The AC510x is available in 32－pin， $4 \times 4 \mathrm{~mm}$ FCOL QFN package．

FUNCTIONAL BLOCK DIAGRAM


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ORDERING INFORMATION

| PART NUMBER | Feedback | Default <br> Output <br> Voltage | Default <br> LDO <br> Voltage | Fsw | ADC <br> Converter | $I^{2}$ C Address | PACKAGE |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ACT5101QI102-T | Internal | 5.1 V | 5.0 V | 500 kHz | Yes | $0 \times 24 \mathrm{~h}$ | FCQFN4x4-32 |
| ACT5101QI103-T | Internal | 5.1 V | 5.0 V | 500 kHz | Yes | $0 \times 66 \mathrm{~h}$ | FCQFN4x4-32 |
| ACT5102QI102-T | External | $\mathrm{n} / \mathrm{a}$ | 5.0 V | 500 kHz | No | $0 \times 24 \mathrm{~h}$ | FCQFN4x4-32 |



Note 1: Standard product options are identified in this table. Contact factory for custom options, minimum order quantity required.
Note 2: All Active-Semi components are RoHS Compliant and with Pb-free plating unless specified differently. The term Pb-free means semiconductor products that are in compliance with current RoHS (Restriction of Hazardous Substances) standards.

Note 3: Package Code designator "Q" represents QFN
Note 4: Pin Count designator " $I$ " represents 32 pins
Note 5: See the CMI Options section at the back of the datasheet for more information on each CMI's settings.

## PIN CONFIGURATION



Figure 1: Pin Configuration - Top View - QFN4x4-32

## PIN DESCRIPTIONS

| PIN | NAME |  |
| :---: | :---: | :--- |
| $1,9,32$ | AGND | Analog Ground. Kelvin connect AGND to the PGND plane. |
| 2 | NC | No Connect. Connect this pin to AGND. |
| 3 | INTBP | Internal Voltage Bypass - Connect a 100nF ceramic capacitor between INTBP and AGND |
| 4 | VREG | Internal VREG LDO output. The output voltage is programmable from 2V to 5.1V. Connect a <br> 1.0uF between VREG and AGND. The maximum current capability for this pin is 100mA. |
| 5,20 | PGND | Power Ground. Connect to large ground plane on PCB with thermal vias. |
| 6 | SDA | I'C Data Input and Output. Needs an external pull up resistor. |
| 7 | SCL | I'C Clock Input. Needs an external pull up resistor. |
| 8 | EN | Enable Input. The converter is enabled when EN is pulled high and disabled when EN is <br> pulled low. |
| 10 | nIRQ | Interrupt Open-Drain Output. nIRQ goes low to indicate a fault condition. nIRQ is <br> referenced to AGND. |
| 11 | ILIM | Input current limit setting pin. Connect a resistor from ILIM to AGND to program the <br> maximum input current. |
| 13 | VINS | Input Voltage Sense Input - Kelvin connect to the input voltage input capacitors. |
| 14 | ISRN | Input current sense resistor positive input. |
| 15 | HSB2 | Input current sense resistor negative input. <br> driver circuitry. Coonnect a 47nF capacitor from HSB2 to SW2 pin |
| 16,17 | VIN | Power Input pins. Connect these pins to 22uF-100uF ceramic capacitors placed as close to <br> the IC as possible. |
| 18,19 | SW2 | Power switching output to external inductor. |
| 21,22 | SW1 | Power switching output to external inductor. |
| 23,24 | VOUT | Output voltage pins. Place 22uF to 44uF decoupling capacitors between VOUT and PGND. |
| 25 | HSB1 | High Side Bias Boot-strap pin. This provides power to the internal high-side MOSFET gate <br> driver circuitry. Connect a 47nF capacitor from HSB1 to SW1 pin |
| 26 | OSRN | Output current sense resistor negative input |
| 27 | OSRP | Output current sense resistor positive input. |
| 28 | STAT | Open drain status output to indicate various IC operating conditions. A LOW indicates the <br> converter is enabled and has a valid output. A HIZ indicates the converter is disabled for <br> any reason |
| 30 | OLIM | Output constant current limit setting pin. Connect a resistor from OLIM to AGND to program <br> the output current. |
| Exposed <br> Pad | PGND | Power Ground. Connect to large ground plane on PCB with thermal vias. |
| ACT5101) | A2D | A2D input pin |
| 30 | FB | Output voltage feedback pin. |
| ACT5102) | COMP | Error Amplifier Output. This pin is used to compensate the converter. |
| 13 |  |  |

## ABSOLUTE MAXIMUM RATINGS

| PARAMETER | VALUE | UNIT |
| :---: | :---: | :---: |
| VOUT | -0.3 to +24 | V |
| OSRP, OSRN | -0.3 to VOUT + 0.3 | V |
| VIN | -0.3 to +23 | V |
| ISRP, ISRN | -0.3 to VIN + 0.3 | V |
| VINS | -0.3 to ISRN + 0.3 | V |
| SW1 | -0.3 to VOUT + 0.3 | V |
| SW2 | -0.3 to VIN + 0.3 | V |
| HSB1 | $\mathrm{V}_{\mathrm{sw} 1}-0.3$ to $\mathrm{V}_{\mathrm{sw} 1}+5.5$ | V |
| HSB2 | $V_{s w 2}-0.3$ to $V_{s w 2}+5.5$ | V |
| VREG | -0.3 to +6 | V |
| SCL, SDA, VREG, STAT, EN, nIRQ, FB, COMP, ILIM, OLIM, A2D | -0.3 to +6 | V |
| AGND to PGND | -0.3 to +0.3 | V |
| Junction to Ambient Thermal Resistance ( $\theta_{\text {JA }}$ ) | 35 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Operating Junction Temperature ( $\mathrm{T}_{\mathrm{J}}$ ) | -40 to 150 | ${ }^{\circ} \mathrm{C}$ |
| Operating Ambient Temperature Range ( $\mathrm{T}_{\mathrm{A}}$ ) | -40 to 85 | ${ }^{\circ} \mathrm{C}$ |
| Store Temperature | -55 to 150 | ${ }^{\circ} \mathrm{C}$ |
| Lead Temperature (Soldering, 10 sec ) | 300 | ${ }^{\circ} \mathrm{C}$ |

Note1: Measured on Active-Semi Evaluation Kit
Note2: Do not exceed these limits to prevent damage to the IC. Exposure to absolute maximum rating conditions for long periods may affect IC reliability.

## SYSTEM CHARACTERISTICS

(VIN $=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise specified)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |

Inputs

| Input voltage Range | VIN |  | 4 |  | 23 | V |
| :--- | :--- | :--- | :---: | :---: | :---: | :---: |
| Input Over Voltage Threshold | VIN_ov | Rising <br> Measured at VINS Pin | 22.75 | 23.5 | 24.25 | V |
| Input Over Voltage Hysteresis | VIN_ov_HYST | VIN Falling <br> Measured at VINS Pin | 300 | -3.0 | VIN_UV | 3.0 |
| VIN UVLO Threshold | VIN_UV | VIN Rising <br> Measured at VINS Pin | $\%$ |  |  |  |
| VIN UVLO Hysteresis | VIN_UVLO_HYST | VIN Falling <br> Measured at VINS Pin <br> VIN=8.4V, VouT=5V | 3 | 4 | 5 | $\%$ |
| Input Current | IN | VIN | 1 | mA |  |  |

Converter Operation

| Output Voltage | Vout_reg_acc | Internal Feedback Mode VOUT_I2C Register = 1 Converter output in PWM mode Measured at VOUT Pin | -1 |  | 1 | \% |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| FB Reference Voltage | Vout_ref_acc | ACT5102 IC only | 1.99 | 2 | 2.01 | V |
| Output Current Range | lout_range | With lout=100\% register setting | 0.5 |  | 5 | A |
| Output Constant Current (measured at OSRN and OSRP pins) | IOUT_OCP | lout_OcP $=0.5 \mathrm{~A}$ to 1 A | -20 | lout | +20 | \% |
|  |  | lout_OCP $=1 \mathrm{~A}$ to 2 A | -15 | lout | +15 | \% |
|  |  | lout_ocp > 2A | -10 | lout | +10 | \% |
| Output Constant Current Undervoltage Protection Threshold | Vout_uvp | VOUT Falling, Enters Hiccup Mode Measured at VOUT pin | 2.62 | 2.72 | 2.82 | V |
| Output Constant Current Undervoltage Protection Deglitch Time | tout_uvp | Vout Falling |  | 7 |  | us |
| Hiccup Mode Off Time | tout_HICCUP | Off time after Vout falls below Vout_uvp |  | 3 |  | s |
| Over-Voltage Threshold | Vout_ovp_ext | $1^{2} \mathrm{C}$ Feedback (ACT5101) Relative to the VOUT Register Setting | 105 | 108 | 111 | \% |
|  |  | External Feedback (ACT5102) Voltage at FB Pin | 2.18 | 2.24 | 2.30 | V |
| Over-Voltage Threshold Hysteresis | Vout_ovp_HYs | Falling Threshold |  | 2 |  | \% |
| Soft Start Time | tout_ss | Relative to the factory default SOFT_START Register Setting. From 0 to 100\% | -30 | $\begin{aligned} & \text { SOFT } \\ & \text { START } \\ & \text { Setting } \end{aligned}$ | 30 | \% |
| Pulldown Current Source | Iout_pD | Vout Output > 2.0 V | 30 | 65 | 120 | mA |

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| Off Delay Current Timer | tout_OfF_diy | EN_DLY Enabled | -10 | OFF DL <br> Y Setting | +10 | \% |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Off Delay Current | IOUT_OFF_LOAD | OFF_LOAD=1 <br> Converter in Buck Mode Only $\mathrm{V}_{\text {IN }}>\mathrm{V}_{\text {OUT }}+0.5 \mathrm{~V}$ | 4 | 5 | 6 | mA |
| Cord Compensation <br> Accuracy | Vout_cc | CORD_COMP: <br> 00: Disabled <br> 01: 100mV <br> 10: 200 mV <br> 11: 300 mV <br> Measured at VOUT Pin | -15 | $\begin{array}{\|l} \hline \text { CORD_C } \\ \text { OMP } \\ \text { Setting } \end{array}$ | +15 | \% |
| Output Slew Accuracy | tout_sLEw | OUTPUT_SLEW <br> 00: 1.0V/ms <br> 01: $0.5 \mathrm{~V} / \mathrm{ms}$ <br> 10: $0.3 \mathrm{~V} / \mathrm{ms}$ <br> 11: $0.1 \mathrm{~V} / \mathrm{ms}$ Internal Feedback Only VOUT_I2C Register = 1 | -20 | OUTPUT <br> _SLEW <br> Setting | +20 | \% |
| Input Current ILIM | 1 LIM | ILIM $=0.5 \mathrm{~A}$ to 1 A | -20 | IILIM | +20 | \% |
|  |  | ILIM $=1 \mathrm{~A}$ to 2 A | -15 | IILIM | +15 | \% |
|  |  | ILIIM $>2 \mathrm{~A}$ | -10 | IILIM | +10 | \% |
| PWM OPERATION |  |  |  |  |  |  |
| Frequency Range | fsw |  | 125 |  | 1000 | kHz |
| Operation Frequency Accuracy | fsw |  | -10\% |  | +10\% | kHz |
| Maximum PWM Duty Cycle | $\mathrm{D}_{\text {max }}$ |  |  | 97 |  | \% |

## INPUT QUIESCENT CURRENTS

| Input Current in HIZ | IIN_HIZ2 | VIN=12V, Converter off, $I^{2}$ C on, VREG <br> on | 35 | $\mu \mathrm{~A}$ |
| :--- | :--- | :--- | :--- | :--- | :---: |
|  | II_HIZ3 | VBAT=12V, Converter off, I2C on, <br> VREG on, A2D Enabled, Fault Monitor <br> Enabled | $\mu \mathrm{A}$ |  |

## INTERNAL MOSFETS

| VOUT to SW1 FET Resistance | R ${ }_{\text {dsonq1 }}$ | $\mathrm{T}_{\mathrm{J}}=25 \mathrm{C}$ |  | 25 |  | $\mathrm{m} \Omega$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SW1 to PGND FET Resistance | R ${ }_{\text {dsonQ2 }}$ | $\mathrm{T}_{\mathrm{J}}=25 \mathrm{C}$ |  | 35 |  | $\mathrm{m} \Omega$ |
| SW2 to PGND FET Resistance | Rdsonq3 | $\mathrm{T}_{\mathrm{J}}=25 \mathrm{C}$ |  | 35 |  | $\mathrm{m} \Omega$ |
| VIN to SW2 FET Resistance | Rdsonq4 | $\mathrm{T}_{\mathrm{J}}=25 \mathrm{C}$ |  | 25 |  | $\mathrm{m} \Omega$ |
| Cycle By Cycle Current Limit | IFET_LIIM | FET_ILIM=0 <br> Q1, Q2, Q3, or Q4 in any mode | 6.5 | 8.5 | 10.5 | A |
|  |  | FET ILIM=1 <br> Q1, Q2, Q3, or Q4 in any mode | 7.75 | 10 | 12.25 | A |

LDO
$\left(\mathrm{VIN}=12 \mathrm{~V}, \mathrm{VOUT}=7.6 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\right.$, unless otherwise specified $)$

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| VREG Regulation Voltage | VREG |  | 2 |  | 5.1 | V |
| VREG Regulation Accuracy | VREG ${ }_{\text {Acc }}$ | At Default Factory Setting | -2 |  | 2 | \% |
| VREG Dropout | VREG ${ }_{\text {dropout }}$ | lout $=100 \mathrm{~mA}$ |  |  | 300 | mV |
| VREG UVLO Threshold | VREGuvLo | VREG Falling | 84 | 88 | 93 | \% |
| VREG UVLO Hysteresis | VREGuvlo_hyst |  |  | 2 |  | \% |
| VREG Current Limit | VREGLIM | $\mathrm{V}_{\mathrm{VIN}}=12 \mathrm{~V}, \mathrm{VREG}=5 \mathrm{~V}$ | 100 | 175 | 250 | mA |
| VREG Current Limit Deglitch | VREGILIm_dg | In current limit |  | 50 |  | us |
| VREG Current Limit Off Time | VREGILIM_off | After Deglitch Time |  | 100 |  | ms |
| VREG Soft Start | VREGss |  |  | 250 |  | us |

## THERMAL PROTECTION

(VIN $=12 \mathrm{~V}$, VOUT $=7.6 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise specified.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNIT |
| :--- | :--- | :--- | :---: | :---: | :---: | :---: | :---: |
| Thermal Regulation and Shutdown |  |  |  |  |  |  |
| Thermal Shutdown Rising Tem- <br> perature | TSHUT | Temperature Increasing | 160 |  | ${ }^{\circ}{ }^{\circ} \mathrm{C}$ |  |
| Thermal Shutdown Hysteresis | TSHUT_HYs |  |  | 30 |  | ${ }^{\circ}{ }^{\circ} \mathrm{C}$ |

## ADC CONVERTER

$\left(\mathrm{VIN}=12 \mathrm{~V}\right.$, VOUT $=7.6 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise specified. $)$

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Total Error | A2D ${ }_{\text {error }}$ | 12 Bit Range |  |  | 0.5 | LSB |
| Conversion Time | A2Dtconv | All 6 Channels |  |  | 100 | ms |
| Conversion Time | A2D ${ }_{\text {tconv }}$ | 1 Channel |  |  | 15 | ms |
| Input Capacitance | A2D ${ }_{\text {cin }}$ |  |  | 5 |  | pF |
| A2D Full Scale Input EXT_IN | A2DFs |  |  | 2.5 |  | V |
| A2D Full Scale OUT | A2Dvout | Measurement input at VOUT pin | 0 |  | 32.5 | V |
| A2D Full Scale VIN | A2Dvin | Measurement input at VIN Pin | 1.5 |  | 25 | V |
| A2D Full Scale OLIM, ILIM | $\begin{aligned} & \text { A2Doliм, } \\ & \text { A2Dııім } \end{aligned}$ |  |  | 2.5 |  | V |

## LOGIC PIN CHARACTERISTICS - EN, STAT, NIRQ

$\left(\mathrm{VIN}=12 \mathrm{~V}, \mathrm{VOUT}=7.6 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\right.$, unless otherwise specified.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNIT |
| :--- | :--- | :--- | :---: | :---: | :---: | :---: |
| EN Input low threshold | VILO |  |  |  | 0.4 | V |
| EN Input high threshold | VIHI |  |  |  | V |  |
| STAT, nIRQ Output Low Volt- <br> age | VoL | Sink Current $=5 \mathrm{~mA}$ |  |  | V |  |
| STAT, nIRQ High Level Leakage <br> Current | loH | Output $=5 \mathrm{~V}$ |  | 1 | uA |  |

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## $I^{2}$ C INTERFACE ELECTRICAL CHARACTERISTICS

(VIN $=12 \mathrm{~V}$, VOUT $=7.6 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise specified.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SCL, SDA Input Low | VıLo | $\mathrm{V}_{10}=1.8 \mathrm{~V}$ |  |  | 0.4 | V |
| SCL, SDA Input High | V IHI | $\mathrm{V}_{10}=1.8 \mathrm{~V}$ | 1.25 |  |  | V |
| SDA Leakage Current | Іон | SDA $=5 \mathrm{~V}$ |  |  | 1 | $\mu \mathrm{A}$ |
| SDA Output Low | Vol | $\mathrm{loL}=5 \mathrm{~mA}$ |  |  | 0.4 | V |
| SCL Clock Frequency | fscl |  | 0 |  | 1000 | kHz |
| SCL Low Period | tscl_Low |  | 0.5 |  |  | us |
| SCL High Period | tscl_H |  | 0.26 |  |  | us |
| SDA Data Setup Time | tsu |  | 50 |  |  | ns |
| SDA Data Hold Time | thd |  | 0 |  |  | ns |
| Start Setup Time | $\mathrm{tst}^{\text {te }}$ |  | 260 |  |  | ns |
| Stop Setup Time | tsp |  | 260 |  |  | ns |
| Capacitance on SCL or SDA PIN | $\mathrm{Cin}^{\text {a }}$ |  |  |  | 10 | pF |
| Noise suppression on SCL and SDA | tdeglitch |  |  |  | 50 | ns |
| $1^{2} \mathrm{C}$ Timeout Function | tout | Total time required for $I^{2} \mathrm{C}$ communication to cause $I^{2} \mathrm{C}$ state machine to reset |  | 100 |  | ms |

Note1: Comply with $\mathrm{I}^{2} \mathrm{C}$ timings for 1 MHz operation - "Fast Mode Plus".
Note2: No internal timeout for $I^{2} C$ operations, however, $I^{2} C$ communication state machine will be reset when entering UV/POR State.
Note3: This is an $I^{2} \mathrm{C}$ system specification only. Rise and fall time of SCL \& SDA not controlled by the IC.
Note4: IC Address is factory configurable to 7'h24, 7'h66.


Figure 2: $\mathrm{I}^{2} \mathrm{C}$ Data Transfer

## FUNCTIONAL DESCRIPTION

## General

ACT510x is a buck-boost converter with integrated MOSFETs. It provides a high efficiency, low external component count, minimal size buck-boost power solution. Its wide input operating range of 3.9 V to 23 V allows operation from many input sources. The ACT5101 output voltage is set by internal registers. It has a built in A/D converter. The ACT5102 output voltage is set by an external resistor divider and does not have an A/D converter.

The ACT510x autonomously switches between buck, buck-boost, and boost modes depending on the input and output voltages. It is optimized for minimum quiescent current in shutdown and standby modes. This makes it ideal for battery powered applications.

The ACT510x can be operated in both stand-alone and host-controlled applications. External resistors set the input and output current limit. Using host controlled $I^{2} \mathrm{C}$ operation, the user has full control over voltage, current, and fault settings.
$I^{2} \mathrm{C}$ operation gives the host full control of operating parameters as well as full knowledge of the operating parameters and fault conditions. A built in ADC provides input voltage, output voltage, input current, output current, and die temperature. The ADC also has one general purpose input to measure an external analog signal.

The ACT510x is highly flexible and contains many $I^{2} C$ configurable functions. The IC's default functionality is defined by its default CMI (Code Matrix Index), but much of this functionality can be changed via $I^{2} \mathrm{C} . I^{2} \mathrm{C}$ functionality includes OV and UV fault thresholds, switching frequencies, current limits, output voltage, slew rates, softstart time, and more. The CMI Options section shows the default settings for each available CMI option. Contact sales@active-semi.com for additional information about other configurations.

## $I^{2} \mathrm{C}$ Serial Interface

To ensure compatibility with a wide range of systems, the ACT510x uses standard I ${ }^{2} \mathrm{C}$ commands. It supports clock speeds up to 1 MHz . The ACT510x always operates as a slave device, and can be factory configured to one of two 7-bit slave addresses. The 7-bit slave address is followed by an eighth bit, which indicates whether the transaction is a read-operation or a writeoperation. Refer to each specific CMI for the IC's slave address

Table 1: ACT510x I $^{2}$ C Addresses

| 7-Bit Slave Address |  | 8-Bit Write <br> Address | 8-Bit Read <br> Address |
| :---: | :---: | :---: | :---: |
| $0 \times 24 \mathrm{~h}$ | 0100100 b | $0 \times 48 \mathrm{~h}$ | $0 \times 49 \mathrm{~h}$ |
| $0 \times 66 \mathrm{~h}$ | 1100110 b | $0 \times \mathrm{Ch}$ | $0 \times \mathrm{CDh}$ |

The $I^{2} \mathrm{C}$ packet processing state machine has a 100 ms timeout function for each $I^{2} \mathrm{C}$ command. If there is greater than 100 ms between a start bit and a stop bit, the ACT510x resets the $I^{2} \mathrm{C}$ packet processing and sets the $I^{2} \mathrm{C}$ _FAULT bit in register $0 x 06 \mathrm{~h}$. Any time the $I^{2} \mathrm{C}$ state machine receives a start bit command, it immediately resets the packet processing, even if it is in the middle of a valid packet. The $\mathrm{I}^{2} \mathrm{C}$ functionality is operational in all states except RESET.
$I^{2} \mathrm{C}$ commands are communicated using the SCL and SDA pins. SCL is the $I^{2} \mathrm{C}$ serial clock input. SDA is the data input and output. SDA is open drain and must have a pull-up resistor. Signals on these pins must meet timing requirements in the Electrical Characteristics. For more information regarding the $\mathrm{I}^{2} \mathrm{C} 2$-wire serial interface, refer to the NXP website: http://www.nxp.com.

## $I^{2} C$ Registers

The ACT510x has an array of internal registers that contain the IC's basic instructions for setting up the IC configuration, output voltages, switching frequency, fault thresholds, fault masks, etc. These registers give the IC its operating flexibility. The two types of registers are described below.

Basic Volatile - These are R/W (Read and Write) and RO (Read only). After the IC is powered, the user can modify the R/W register values to change IC functionality. Changes in functionality include things like masking certain faults. The RO registers communicate IC status such as fault conditions. Any changes to these registers are lost when power is recycled. The default values are fixed and cannot be changed by the factory or the end user.

Basic Non-Volatile - These are R/W and RO. After the IC is powered, the user can modify the R/W register values to change IC functionality. Changes in functionality include things like output voltage settings, startup delay time, and current limit thresholds. Any changes to these registers are lost when power is recycled. The default values can be modified at the factory to optimize IC functionality for specific applications. Please consult sales@active-semi.com for custom options and minimum order quantities.

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When modifying only certain bits within a register, take care to not inadvertently change other bits. Inadvertently changing register contents can lead to unexpected IC behavior.

## STATE MACHINE

ACT510x contains an internal state machine with three internal states: RESET, HIZ, and POWER ON.

## RESET State

The IC enters the RESET state when power is applied. All registers are reset to their default values. $I^{2} \mathrm{C}$ is not functional in RESET. The IC transitions to the HIZ state when VIN goes above 3.9V
configuration can be changed. The IC enters HIZ from RESET and then either stays in HIZ or transitions to the POWER ON state. Note that the HIZ Register overrides the EN pin settings and may hold the IC in HIZ mode. See the HIZ section for more details.

## POWER ON State

In the POWER ON state, the ACT510x transfers power from VIN to VOUT to provide a regulated output voltage. The IC enters this state with the EN pin or the EN_OVERRIDE register. Once in POWER ON, the IC follows the separate POWER ON State Machine. See the POWER ON State machine for more details.

## HIZ State

HIZ mode is a low power state with the switching converter disabled. In this mode, $I^{2} \mathrm{C}$ is active and the IC


Figure 3: Operating Modes State Machine

## POWER ON STATE MACHINE

The ACT510x has a dedicated POWER ON state machine. This state machine handles the startup, normal operation and fault conditions.

## Reset State (RST)

The POWER ON state machine always starts from the RST state. All converter operation starts from this state. In this state, the switcher is disabled and the state machine is waiting for all the required conditions to move to the SS state.

After all the following fault conditions are cleared, the IC starts the Enable Delay Timer. This timer is controlled by ${ }^{2}$ C bit EN_DLY[1:0] in register 0x0Fh. Once the timer has expired, the state machine moves to the SS state.

## Reset Faults:

VIN UV Shutdown voltage: This fault is active when the input voltage is lower than the programmed VIN UV Shutdown voltage. This shutdown voltage is set by two $I^{2} \mathrm{C}$ registers: VIN_UV in register 0x0Fh and VIN_UV_OFFSET in register 0x1Ah. The actual shutdown voltage is equal to the programmed VIN_UV_OFFSET voltage minus the programmed VIN_UV voltage. This fault self-clears when VIN is higher than the UV Shutdown voltage.

VREG LDO OK - This fault is set when an LDO fault is detected. This includes the 100 msec timeout period. This fault automatically clears when the VREG LDO has exited the faulted condition. Note: This fault can be masked to allow the state machine to exit RST while there is a fault on the VREG LDO by using the ${ }^{2} \mathrm{C}$ bit DIS_VREG_FLT in register $0 \times 10$ Bit 1.

Watchdog Timer Fault: This fault is active if the watchdog timer is enabled and the timer times out. This fault clears when the watchdog timer is reset or cleared. It can be reset by writing a 1 into the $I^{2} \mathrm{C}$ bit WATCHDOG_RESET in register $0 x 00 \mathrm{~h}$. It can be cleared by disabling the watchdog timer by setting $I^{2} \mathrm{C}$ bits WATCHDOG[1:0] $=0 \times 00 \mathrm{~h}$.

FET Overcurrent Fault: This fault is set if a switching FET exceeds the cycle-by-cycle current limit for 8 (or 16) consecutive cycles. The FET_OC fault is latched. To clear this latch, the IC must exit the POWER ON state and enter HIZ mode. This is typically accomplished by toggling the EN pin or setting the HIZ register to 1.

VIN Overvoltage: This fault is set if VIN exceeds the $\mathrm{V}_{\mathrm{VIN}} \mathrm{ov}$ voltage, 23.5 V . The OV fault self-clears when VIN drops below VVIN_ov and the IC exits the RST state.

Die Thermal Shutdown (TSD): This fault is active when die temperature exceeds the $\mathrm{T}_{\text {shut }}\left(160^{\circ} \mathrm{C}\right)$ temperature. This fault self-clears when the die temperature cools down by the temperature hysteresis, Tshut_hyst $\left(30^{\circ} \mathrm{C}\right)$. This fault cannot be cleared or masked. The IC must cool down before exiting the RST state.

## Softstart State (SS)

In this state, the IC enables the converter and softstarts the output voltage.
The state machine enters the SS state from the RST state when all faults are cleared. The state machine transitions to the REG state after the output is softstarted an in regulation.

The softstart time is controllable by the $I^{2} \mathrm{C}$ bit SS in register $0 \times 0 \mathrm{Eh}$. If a fault occurs during the softstart, the state machine jumps back to the RST state and disables the converter. Once the soft start is done, the IC jumps to the REG state.

## Regulation State (REG)

The normal regulation occurs in the REG state. If a major fault occurs during operation the IC will jump back to the reset state and disable the converter. During this state, the converter can be disabled with a light load condition. Additionally, if the output drops below Vout_uvp (3.0V), the IC will go into a hiccup mode to protect the output in a shorted condition.


Figure 4: POWER ON State Machine Diagram

## Light Load Disable State (LL_DIS)

In the state, the converter is disabled to minimize load on the input supply. This is especially useful in battery applications. It prevents the converter from switching with no load.

The state machine enters LL_DIS when it senses a light load for longer than the light load time out time. This time is set by $\mathrm{I}^{2} \mathrm{C}$ bit OFF_DLY[1:0] in register 0x0Eh. Note that the converter only enters LL_DIS when operating in buck mode. It does not enter LL_DIS when in boost or buck-boost mode.

The state machine can only exit LL_DIS when the IC exits the POWER ON state with the EN pin or HIZ register.

## Hiccup / Vout Fault State (HICCUP)

This state is a fault state that minimizes overall IC power dissipation in extreme output overload conditions.

The state machine enters this state when the output cannot support the load. When the output reaches the maximum programmed output current, it clamps the current and the voltage starts to drop. If the load increases, the output voltage drops even further. If it drops below Vout_uvp (3.0V), the converter is disabled for 3s. After 3s, it automatically moves to RST and restarts. If there is a fault on the output, this cycle continues until the fault is removed.

## PIN FUNCTIONS

## VIN

VIN is the ACT510x input power pin. Input voltage sensing is measured at the VIN pin. Connect input bypass capacitors directly between VIN and PGND.

## ISRP

ISRP is the positive sense pin for input current sensing. ISRP requires an input RC filter. Refer to the Input Current Regulation section for more details. ISRP must be Kelvin connected to the input current sense resistor. Connect the input current sense resistor between ISRP and ISRN.

## ISRN

ISRN is the negative sense pin for input current sensing. ISRN requires an input RC filter. Refer to the Input Current Regulation section for more details. ISRN must be Kelvin connected to the input current sense resistor. Connect the input current sense resistor between ISRP and ISRN.

## SW1, SW2

SW1 and SW2 are the switch nodes for the internal buck-boost converter. SW1 switches between VOUT and PGND when the IC operates in buck-boost and boost modes. SW2 switches between VIN and PGND when the IC operates in buck and buck-boost modes. Connect the inductor between the SW1 and SW2 pins.

## HSB1, HSB2

HSB1 and HSB2 provide power to the internal high-side MOSFET gate driver circuitry. Connect a $47 n F$ capacitor from HSB1 to SW1. Connect a 47nF capacitor from HSB2 to SW2.

## VOUT

VOUT is the ACT510x output power pin. Connect output bypass capacitors directly between VOUT and PGND.

## VINS

VINS is the input voltage sense pin. Kelvin connect input VINS to the input bypass capacitors.

## OSRP

OSRP is the positive sense pin for the output current. OSRP requires an input RC filter. Refer to the Setting Maximum Output Current section for more details. OSRP must be Kelvin connected to the output current sense resistor. Connect the output current sense resistor between OSRP and OSRN.

## OSRN

OSRN is the negative sense pin for the output current. OSRN requires an input RC filter. Refer to the Setting Maximum Output Current section for more details. OSRN must be Kelvin connected to the output current sense resistor. Connect the output current sense resistor between OSRP and OSRN.

## ILIM

ILIM sets the maximum input current. Connect a resistor between ILIM and AGND to set the current limits. The ILIM current limit can be scaled using ${ }^{2}$ C. In some operating conditions, ILIM requires additional RC compensation. Refer to the Input Current Regulation section for more details.

## OLIM

OLIM sets the maximum output current. Connect a resistor between OLIM and AGND to set the output current limit. The OLIM current limit can be scaled using $I^{2} \mathrm{C}$. In some operating conditions, OLIM requires additional RC compensation. Refer to the Setting Maximum Output Current section for more details.

## INTBP

INTBP is the internal bias voltage output pin. INTBP is supplied by an internal linear regulator. Do not power external circuity from the INTBP pin. Connect a 100 nF ceramic capacitor between INTBP and AGND.

## VREG

VREG is the internal LDO output pin. The internal LDO is programmable between 2 V and 5.1 V . Its maximum output current capability 100 mA . Connect a 1 uF ceramic capacitor between VREG and AGND

## EN

EN is the active high enable input. Pulling EN high enables the converter. The EN polarity is configurable via NVM to make it active low or active high. Active high is the default. EN is 5 V compliant.

## STAT

STAT is an open drain status pin. It indicates the state of the converter. It goes low to indicate the converter is enabled and has a valid output voltage. It goes HIZ to indicate the converter is disabled or that the converter is enabled but in a fault condition.

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Table 2: STAT Pin State

| State | STAT Output Pin |
| :--- | :--- |
| Output Enabled and Output <br> Valid | LOW |
| Output Disabled | HIZ |
| Output Enabled In Fault, Hic- <br> cup, or Light Load states | HIZ |

## COMP

COMP is the converter compensation pin. Connect the compensation components between COMP and AGND. See the Compensation section for details.

## A2D/FB

This is a dual function pin. It is an A2D input for the ACT510x. Connect this pin directly to the voltage to be measured. Note that the ADC full scale input voltage is 2.5 V . It is the output voltage feedback pin for the ACT5102.

## nIRQ

ACT510x has an interrupt pin to inform the host of any fault conditions. In general, any IC function with a status bit asserts nIRQ pin low if the status changes. The status changes can be masked by setting their corresponding register bits. If nIRQ is asserted low, the fault must be read before the IC deasserts $\operatorname{nIRQ}$. If the fault remains after reading the status bits, nIRQ remains asserted. Refer to the nIRQ Interrupt Pin (nIRQ) section for more details.
nIRQ is an open-drain output and should be pulled up to an appropriate supply voltage with a $10 \mathrm{k} \Omega$ or greater pull-up resistor. nIRQ is 5 V compliant

## SCL, SDA

SCL and SDA are the $I^{2} \mathrm{C}$ clock and data pins to the IC They have standard $I^{2} \mathrm{C}$ functionality. They are opendrain outputs and each require a pull-up resistor. The pull-up resistor is typically tied to the system's uP IO pins. The pullup voltage can range from 1.8 V to 5.0 V . SCL and SDA are open drain and are 5 V compliant

## NC

This pin is not used and should be connected directly to AGND

## PGND

The PGND pin is the buck-boost converters' power ground. The internal FETs connect directly to the PGND pins. The power supply input and output capacitors must connect to the PGND pins.

## AGND

The AGND pin is the IC's analog ground pin. It is a "quiet" ground pin that is separate and isolated from the high power, high current carrying PGND ground plane. Connect the non-power components to AGND. AGND must be Kelvin connected to the PGND pin in a single location.

## Exposed PAD

The Exposed pad is connected directly to the PGND pins and must be soldered to the top side ground plane. Place thermal vias under the Exposed PAD to improve the IC's thermal performance.

## BUCK-BOOST OPERATION

The ACT510x is a monolithic buck-boost converter. Four internal, low resistance, NMOS switches minimize the application circuit size and reduce power losses to maximize efficiency. Internal high side gate drivers, which require only two small external capacitors, further simplify the design process. An advanced switch control algorithm allows the buck-boost converter to maintain constant output voltage regulation with input voltages that are above, equal to, or below the regulated output voltage. The ACT510x automatically transitions between these three operating modes, depending on the input to output voltage ratios.

## Power Stage

Figure 5 shows the 4-switch, buck-boost power stage. The converter operates with current mode control. The internal control algorithm reconfigures the IC between a buck, a boost, and a buck-boost topology as needed. This reduces power dissipation and maximizes efficiency because only two FETs switch when in it operates in buck or boost mode. Table 3 shows the switch configuration in each topology. The voltage transition between buck to buck-boost and from buck-boost to boost modes is set by ${ }^{2} \mathrm{C}$ bits XOVER_ADJ_BUCK and XOVER_ADJ_BOOST. With a fixed output voltage and a decreasing input voltage, the IC switches from buck mode to buck-boost mode when VIN - VOUT < XOVER_AJD_BUCK, which is typically 1V. It switches from buck-boost to boost mode when VOUT - VIN > XOVER_ADJ_BOOST, which is typically 2V. These values are set at the factory to optimize efficiency and performance for each CMI.

Q1-Q4 are all internal, N-ch MOSFETs to minimize size and maximize efficiency.


Figure 5: 4-Switch Buck-Boost Power Stage

Table 3: Buck-Boost Switch Configuration

|  | BUCK | BUCK- <br> BOOST | BOOST |
| :--- | :--- | :--- | :--- |
| Q1 | ON | SWITCHING | SWITCHING |
| Q2 | OFF | SWITCHING | SWITCHING |
| Q3 | SWITCHING | SWITCHING | OFF |
| Q4 | SWITCHING | SWITCHING | ON |

Figure 6 shows the power stage operating modes. A typical example of how the converter switches between modes can be explained with an example using a car charger cigarette lighter adapter (CLA) with a 12 V input voltage and USB-PD3.0 + PPS compatible output voltages. When the CLA is first plugged in, the ACT510x operates in buck mode to generate 5 V out (point A ). If the downstream device requests a 9 V (point $B$ ), the ACT510x still operates in buck mode. If the downstream device requests 12 V (point C), the ACT510x operates in buck-boost mode. If the downstream device requests 15 V or 20 V (points $D$ and $E$ ), the ACT510x operates in boost mode.


Figure 6: ACT510x Operating Modes

## PFM/PWM Operation

At light loads, the ACT510x operates in the PFM (pulse skipping) mode to reduce switching losses. PFM mode can be disabled by the $I^{2} \mathrm{C}$ bit DIS_PFM in register $0 \times 10 \mathrm{~h}$. Setting this bit to 0 enables PFM mode. Setting this bit to 1 forces PWM mode.

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## Out-of-Audio Mode

When the IC operates in PFM mode, it reduces the switching frequency. At very light loads, the IC can switch in the audio range. The ACT510x features an Out-of-Audio mode that prevents switching below 31.25 kHz . Set the $\mathrm{I}^{2} \mathrm{C}$ bit AudioFreqLimit $=1$ to enable this feature.

## GENERAL DESCRIPTION

## Startup

When power is first applied, the ACT510x starts up in HIZ mode and all registers are reset to their default values. The internal LDO, VREG, is enabled and the IC can communicate via $I^{2} \mathrm{C}$. The ADC can be used at this time. If the EN pin is pulled high, the IC transitions to the POWER ON mode.

## VREG LDO

The ACT510x contains a 100 mA internal linear regulator that can be used to power other circuity in the system. VREG is enabled when the IC enters HIZ mode and input voltage stays above 3.9 V .
$I^{2} \mathrm{C}$ bit VREG_DIS in register $0 \times 01 \mathrm{~h}=0$. This register bit can be programmed Hi or Low from the factory to match system level requirements.

The VREG output voltage is programmable between 2.0 V and 5.1 V in 100 mV steps via $\mathrm{I}^{2} \mathrm{C}$ bits VREG[4:0] in register 0x11h.
$V_{\text {VREG }}=2.0 \mathrm{~V}+0.1 \mathrm{~V}$ * VREG[4:0].
Where VREG[4:0] is the decimal equivalent of the value in this register. For example, if VREG[4:0] = 01101b (13 decimal), the output voltage $=2.0 \mathrm{~V}+0.1 \mathrm{~V} * 13=3.3 \mathrm{~V}$.

The VREG input can come from either the VIN pin or the VOUT pin. The ACT510x contains a Smart Diode Selector input that minimizes power dissipation by selecting the lower of these two input sources. The IC powers VREG from the lower of the VIN or VOUT pins. However, if the lower voltage pin cannot provide the headroom needed to regulate VREG, it selects the higher voltage pin.

The Smart Diode Selector can be overridden and manual control can be selected using the $I^{2} C$ bits VREG_OVERRIDE and VREG_SELECT in register 0x0Bh. When VREG_OVERRIDE = 0, the Smart Diode Selector is active. When VREG_OVERRIDE = 1, the VREG input is determined by VREG_SELECT. When VREG_SELECT $=0$, the input is VOUT. When VREG_SELECT $=1$, the input is VIN.

If VREG LDO is overloaded or not within spec, the buckboost converter shuts down, and $I^{2} \mathrm{C}$ fault bit VREG_OC_UVLO in register $0 x 05 \mathrm{~h}$ is set to 1 .

Additionally, if VREG is held in current limit for more than 90us, it shuts down for 100 ms to prevent damage. It tries to restart after 100 ms . It continues this cycle until the current limit condition is removed. VREG also contains UVLO detection, which is set to $88 \%$ of the programmed output voltage.

If the VREG output is in current limit for 90usec, or the VREG voltage is below the UVLO threshold, the state machine moves to the RST state and the buck-boost converter stops switching. The buck-boost converter can be programmed to ignore an overvoltage or undervoltage fault with $I^{2} \mathrm{C}$ bits DIS_VREG_FLT in register $0 \times 10 \mathrm{~h}$. If this bit is set to 1 , the IC continues to operate through the fault condition.

VREG requires a high quality, low-ESR, ceramic output capacitor. A $1 u F$ is typically suitable. The maximum allowable output capacitance is $4 \mu \mathrm{~F}$ for a 5 V output and $6 \mu \mathrm{~F}$ for a 3.3 V output. The maximum capacitance limitation prevents the LDO from reaching current limit at startup. The output capacitor should be a X5R, X7R, or similar dielectric. The effective output capacitance must be greater than 0.7 uF to ensure LDO stability.

VREG contains a fixed 250us soft-start to reduce inrush current.

## Interrupt Output Pin (nIRQ)

The nIRQ output pin can be used to signal a fault or other system effects. The conditions below can assert the nIRQ pin. All fault conditions can be individually masked using the $I^{2} \mathrm{C}$ nIRQ Control Registers 0x1Eh, $0 \times 1 \mathrm{Fh}$, and $0 \times 20 \mathrm{~h}$. To clear the interrupt and de-assert the nIRQ pin, write a 1 into ${ }^{2} \mathrm{C}$ bit nIRQ_CLEAR in register $0 \times 05 \mathrm{~h}$. nIRQ _CLEAR is a self-clearing register bit. nIRQ_CLEAR always returns a 0 when read, even after it is set to 1 .

## General nIRQ Fault Conditions

1. Watchdog Expired - If the watchdog timer expires at any time, it asserts nIRQ. This is a level sensitive function. The watchdog timer must be reset or disabled and a 1 must be written into nIRQ_CLEAR to de-asserted nIRQ.
2. VREG LDO Overcurrent or Under-voltage Lockout - Any time the VREG LDO is in overcurrent or under-voltage lockout, nIRQ is asserted. This is a level sensitive function. VREG must be in regulation AND a 1 must be written into nIRQ_CLEAR to deassert nIRQ. If the

VREG LDO is in the 100 ms shutdown wait period, it will not clear the nIRQ output. This fault is detected in HIZ and POWER ON Modes.
3. Over Temperature Shut Down - Any time the die temperature exceeds the Tshut $\left(160^{\circ} \mathrm{C}\right)$ threshold, nIRQ is asserted. This is a level sensitive function. The die temperature must be below the $\mathrm{T}_{\text {shut_hyst }}$ AND a 1 must be written into nIRQ_CLEAR to deassert nIRQ. Die TSD is active in all modes.
4. FET Overcurrent Fault - If the IC is disabled from switching because of a FET overcurrent fault, $n$ IRQ is asserted. This is a level sensitive function. This fault is latched, so the latch must cleared by manually going into HIZ Mode AND a 1 must be written into nIRQ_CLEAR to deassert nIRQ.
5. ADC Data Ready - If the ADC is enabled, and a conversion is completed, nIRQ is asserted. This is an edge triggered event. A 1 must be written into nIRQ_CLEAR to deassert nIRQ. This is active in all modes when the ADC is enabled.
6. HIZ Enter - The ACT510x asserts nIRQ when it enters HIZ mode. This is an edge triggered event. 1 must be written into nIRQ_CLEAR to deassert nIRQ. The IC asserts nIRQ when entering HIZ mode to signal a fault or other condition that might have caused the IC to jump out POWER ON mode un-expectantly.
7. $I^{2} C$ Fault - If an $I^{2} \mathrm{C}$ command takes more than 100 ms between the start bit and the stop bit, nIRQ is asserted. This is an edge triggered event. The $I^{2} \mathrm{C}$ state machine clears out any partial data, resets, and waits for another start bit for another $I^{2} C$ command. The state machine clears and restarts the 100 ms timer when it receives the next start bit.
8. VIN Above Vvin_ov (23.5V) - If VIN is above $\mathrm{V}_{\text {VIn_ov }}(23.5 \mathrm{~V}$ ), nIRQ is asserted. This is a level triggered event. 1 must be written into nIRQ_CLEAR to deassert nIRQ. This fault is detected in both the HIZ state and the POWER ON state.
9. VIN UV Fault - If the input voltage at the VINS pin is below the VIN_UV_OFFSET threshold, nIRQ is asserted. This is a level triggered event. VIN must be in the valid range AND 1 must be written into nIRQ_CLEAR to deassert nIRQ.
10. Light Load Disable State - Any time the IC enters the LL_DIS state, $n I R Q$ is asserted. This is an edge triggered event. A 1 must be written into nIRQ_CLEAR to deassert nIRQ. The IC does not need to exit the LL_DIS state to deassert nIRQ.
11. Hiccup Mode / Vout Fault State - Any time the IC enters the HICCUP state, nIRQ is asserted. This is an edge triggered event. A 1 must be written into nIRQ_CLEAR to deassert nIRQ.

## Die Thermal Regulation

The ACT510x monitors the internal junction temperature, $\mathrm{T}_{\mathrm{J}}$, to avoid overheating When $\mathrm{T}_{\mathrm{J}}$ exceeds the maximum thermal regulation limit set by $I^{2} \mathrm{C}$ bits TREG [1:0], the IC reduces the output current to lower the die temperature. It effectively reduces the output current limit value. If the load current is not reduced, the output voltage will drop and generate an undervoltage fault. The maximum operating junction temperature is programmable to $80^{\circ} \mathrm{C}, 100^{\circ} \mathrm{C}$, or $120^{\circ} \mathrm{C}$ to allow the user to optimize their system thermal performance. This function can be disabled by setting TREG[1:0] $=00$.

## HIZ Mode

The ACT510x HIZ mode is a low power state where the buck-boost converter is disabled. The LDO can be enabled or disabled by $I^{2} \mathrm{C}$ bit VREG_EN in register $0 \times 01 \mathrm{~h}$. The IC always starts up in HIZ mode before going to POWER ON mode. If the IC is not enabled, it stays in the HIZ state indefinitely.

The IC enters HIZ mode from POWER ON mode when the converter is disabled or if a 1 is written into $I^{2} \mathrm{C}$ bit HIZ in register 0x00h.

## Thermal Shutdown

The ACT510x has thermal shutdown protection that disables the buck-boost converter when IC junction temperature exceeds Tshut $\left(160^{\circ} \mathrm{C}\right)$. The fault register TSD is set to 1 and latched when a TSD fault is detected. The converter restarts automatically after the junction temperature falls below $\mathrm{T}_{\text {SHUT }}$ - Tshut_hyst, or $_{\text {sup }}$ approximately $160^{\circ} \mathrm{C}-30^{\circ} \mathrm{C}=130^{\circ} \mathrm{C}$. After the system restarts, the TSD bit is latched until it is read by $\mathrm{I}^{2} \mathrm{C}$.

## FET Over Current Protection

The ACT510x closely monitors the HSFETs and LSFETs currents for safe operation. If any FET exceeds the maximum cycle-by-cycle current limit threshold set by ${ }^{2} \mathrm{C}$ bit FET_ILIMIT in register $0 \times 01 \mathrm{~h}$, the FET is immediately turned off for that switching cycle. Three thresholds of 5.7A, 8.5A, and 10A are available. If a FET detects the current limit for eight continuous cycles, the buck-boost converter is latched off.

After FET Overcurrent protection is triggered, there are two ways to clear the fault to let the converter resume normal operation. First is to set $\mathrm{I}^{2} \mathrm{C}$ bit DIS_OCP_SHUTDOWN = 1 in register 0x01h. It can also be cleared by putting the IC into HIZ mode. Simply toggle the EN pin low and back high.

Overcurrent protection can be disabled by setting the ${ }^{2} \mathrm{C}$ bit DIS_OCP_SHUTDOWN = 1 .

## Watchdog Timer

The ACT510x contains a watchdog timer to detect system level communication failures. The watchdog timer requires the host to periodically write a 1 into $I^{2} \mathrm{C}$ bit WATCHDOG_RESET in register $0 x 00 \mathrm{~h}$. If the host latches up or is unable to perform the write command before the watchdog timer times out, the IC enters FAULT mode and disables the switching converter. The timer resets after each write to WATCHDOG_RESET. WATCHDOG_RESET is an auto-clearing register. It automatically resets back to 0 after it is set to 1 .

The timeout value is controlled by $1^{2} \mathrm{C}$ bit WATCHDOG[1:0] in register $0 \times 01 \mathrm{~h}$. It can be set between 80 s and 320 s . If the IC is used in stand-alone operation, the watchdog timer can be disabled by setting WATCHDOG[1:0] $=00$.

WATCHDOG is always disabled in HIZ Mode and cannot be enabled in HIZ. In addition, the timer is reset to 0 when entering HIZ mode and automatically starts counting when exiting HIZ mode.

## CONVERTER OPERATION

## Enable / Disable

The ACT510x is enabled and disabled from HIZ mode. When enabled, the converter operates in the POWER ON mode. When disabled, the IC operates in the HIZ mode. The EN pin is the typical method to enable and disable the IC. If $I^{2} \mathrm{C}$ on/off control is required, the system microprocessor can enable and disable the IC via the EN and EN_OVERRIDE bits in register 0x0Eh. Set EN_OVERRIDE $=1$ to override the EN pin input. Then set $\mathrm{EN}=1$ to enable the converter and set EN $=0$ to disable the converter. Figure 7 shows both the hardware and $I^{2} \mathrm{C}$ conditions required to enter turn the converter on.

Note that in all cases, the $\mathrm{I}^{2} \mathrm{C}$ bit HIZ in register $0 \times 00 \mathrm{~h}$ must be $=0$ to enter enable the converter. When HIZ = 1 , the IC is forced into HIZ mode.


Figure 7: Conditions to Enter the POWER ON State from the HIZ State

After the IC is enabled and in the POWER ON mode, the conditions to exit POWER ON mode (disable the converter) change. When the converter is disabled, the IC state machine must go to HIZ mode. There are several ways to transition from POWER ON mode to HIZ mode.

1. Set the $\mathrm{I}^{2} \mathrm{CHIZ}$ bit $=1$
2. Set the $I^{2} \mathrm{C}$ EN bit $=0$
3. Pull the EN pin LOW and set the $I^{2} \mathrm{C}$ EN_OVERRIDE bit = 0 .
4. The IC also exits POWER ON mode if there is an overvoltage condition for longer than 100ms.


Figure 8: Conditions to Enter HIZ State from POWER ON State

## Output Voltage Setting

The output voltage is programmable between 2.96 V and 23.42 V in 20 mV steps via by $\mathrm{I}^{2} \mathrm{C}$ bits VOUT[9:0] in registers $0 \times 13 \mathrm{~h}$ and $0 \times 14 \mathrm{~h}$.
$V_{\text {OUT }}=2.96 \mathrm{~V}+20 \mathrm{mV} * \operatorname{VOUT}[9: 0]$
Where VOUT[9:0] is the decimal equivalent of the value in this register. For example, if VOUT[9:0] = 0111000100 b (452 decimal), the output voltage $=2.96 \mathrm{~V}$ +0.02 V * $452=12.00 \mathrm{~V}$.

When changing from one output voltage to another, the slew rate is programmable between $1 \mathrm{~V} / \mathrm{ms}$ and $0.1 \mathrm{~V} / \mathrm{ms}$ by ${ }^{2} \mathrm{C}$ bits OUTPUT_SLEW[1:0] in register $0 \times 10 \mathrm{~h}$. This allows the output to conform to QC2.0/QC3.0/USB PD/ USB PD + PPS functions for higher output voltages.

The input voltage must always stay above the minimum allowable input voltage. This voltage is defined by registers VIN_UV_OFFSET in register 0x1Ah and VIN_UV
in register $0 \times 0 \mathrm{Fh}$. The minimum allowable input voltage is the VIN_UV_OFFSET voltage minus the VIN_UV voltage. If the input voltage drops below this value, the IC turns off the output and goes to the RST state.

## Active Discharge

When changing the output voltage to a higher level, the switcher ramps the output voltage by the programmed slew rate. When the output voltage is programmed from a higher to a lower voltage, the voltage drops at a rate determined by the output capacitance and the load current. To minimize the fall time in no-load conditions, the ACT510x can provide a 70 mA sink when the output is transitioning to a lower output voltage. Enable this feature by writing 1 into $I^{2} \mathrm{C}$ bit PULLDOWN_RAMP. The 70 mA load turns on until the output voltage goes into regulation.

## Enable Delay

Once the IC has the valid conditions for startup, the Enable Delay timer is enabled. The timer options allow a 0 ms to 1 s delay. The startup delay is controlled by the ${ }^{2} \mathrm{C}$ bits EN_DLY[1:0]

## Soft Start

After the Enable Delay has completed, the IC starts the output using a soft start function programmable by the $I^{2} \mathrm{C}$ bits SOFT_START in register 0x0Eh. The softstart time is independent of the output voltage setting.

## Setting Maximum Output Current

The maximum output current, lout_max, is set by a combination of a current sense resistor, an OLIM resistor, and a scaling factor defined by $I^{2} \mathrm{C}$ bits $\mathrm{CC}[6: 0]$ in register $0 \times 17 \mathrm{~h}$. The maximum allowable output current is 5 A . Figure 9 shows the hardware circuitry that sets Іоцім. IoLIM is the maximum output current set by hardware. The actual output current limit, lout, can be scaled from 1\% to $100 \%$ of loum in $1 \%$ steps. The following equation defines the final maximum output current.

$$
\mathrm{I}_{\text {OUT_MAX }}=\mathrm{I}_{\text {OLIM }} * \mathrm{CC}[6: 0]
$$

Where loum is the hardware programmed output current limit and $C C[6: 0]$ is the scaling factor. $C C[6: 0]$ is the decimal equivalent value in this register. For example, if lolim, is programmed to 4A and CC[6:0] = 1001011b (75\% decimal), the final maximum output current $=4 \mathrm{~A} * 0.75$ $=3 \mathrm{~A}$.
Note that CC[6:0] is a 7 bit register and can be programmed between $0 \times 00 \mathrm{~h}$ and $0 \times 7 \mathrm{Fh}(0 \%$ and $127 \%)$. If a value of $0 \times 00 \mathrm{~h}$ is written to the register, the register retains $0 \times 00 \mathrm{~h}$, but the IC sets the maximum output current to $1 \%$. If a value above $0 \times 64 \mathrm{~h}(100 \%)$ is written to
the register, the IC retains the written value, but sets the maximum output current to $100 \%$.


Figure 9: Output Current Limit Circuitry

The current sense resistor and OLIM resistor set the lolim current.

$$
I_{\text {OLIM }}=\frac{1000 \frac{V^{2}}{A}}{R_{\text {OLIM }} * R_{\text {CS_OUT }}}
$$

Where Rolim is the resistor from the OLIM pin to AGND in ohms and Rcs_out is the current sense resistor value in ohms. The term $1000 \mathrm{~V}^{\wedge} 2 / \mathrm{A}$ is a constant with the units volts^2/Ampere.

The current sense resistor, Rcs_out, value should be chosen to give a maximum current sense voltage between 20 mV and 50 mV . 50 mV is the absolute maximum allowable voltage. Using lower voltages reduces the resistor's power dissipation, but decreases accuracy. At lower output currents, additional RC compensation must be placed in parallel with Rolim. Table 4 gives recommended resistor values for different values of loцıм current. Contact sales@active-semi.com for compensation information if other configurations are required.

Table 4: Output Current Component Selection

| Switching Frequency $=125 \mathrm{kHz}$ |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
| lolim <br> (A) | $\begin{gathered} \hline \text { Rcs } \\ (\mathrm{m} \Omega) \\ \hline \end{gathered}$ | Rolim $(k \Omega)$ | Rcs_comp (k $\Omega$ ) | $\begin{gathered} \hline \text { Ccs_comp } \\ (\mathrm{nF}) \\ \hline \end{gathered}$ |
| 5 | 10 | 20 | NA | NA |
| 4 | 10 | 25 | NA | NA |
| 3 | 10 | 33 | 10 | 330 |
| 2 | 10 | 50 | 10 | 330 |
| 1.5 | 20 | 33 | 10 | 330 |
| 1 | 20 | 50 | 10 | 330 |
| Switching Frequency $=250 \mathrm{kHz}, 500 \mathrm{kHz}, 1 \mathrm{MHz}$ |  |  |  |  |
| Iolim <br> (A) | $\begin{gathered} \hline \text { Rcs } \\ (\mathrm{m} \Omega) \\ \hline \end{gathered}$ | $\begin{gathered} \text { Roulm } \\ (\mathrm{k} \Omega) \\ \hline \end{gathered}$ | Rcs_comp $(\mathbf{k} \Omega)$ | $\begin{gathered} \hline \text { Ccs_comp } \\ (\mathrm{nF}) \end{gathered}$ |
| 5 | 10 | 20 | NA | NA |
| 4 | 10 | 25 | NA | NA |
| 3 | 10 | 33 | NA | NA |
| 2 | 10 | 50 | 15 | 56 |
| 1.5 | 20 | 33 | 10 | 100 |
| 1 | 20 | 50 | 10 | 100 |

To eliminate noise in the current measurement circuit, the current sense voltage must be filtered. The recommended values are RosRp $=$ RosRn $=30.1 \mathrm{ohm}$ and CosR $=100 \mathrm{nF}$. These values can be scaled up or down, but Rosrp must be between 20ohm and 50ohm, and the resulting filter cutoff frequency must be between 20 kHz and 30 kHz .

The actual output current can be measured with the OLIM pin. The OLIM voltage is directly proportional to the output current. The following equation calculates the actual output current.

$$
I_{\text {OUT }}=I_{\text {OLIM }} \frac{V_{\text {OLIM }}}{2 V}
$$

Where lolim is the hardware programmed $100 \%$ output current limit in amps and Volim is the voltage measured at the OLIM pin.

## Constant Output Current Regulation

When the output current tries to increase above lout_max, the converter transitions from constant output voltage regulation to constant output current regulation. The output voltage will drop to maintain a constant output current.
$I^{2} \mathrm{C}$ bit OUTPUT_CC in register 0x20h indicates if the converter is operating in constant voltage or current regulation. When this bit $=0$, the $I C$ is regulating in constant voltage mode. When this bit $=1$, the $I C$ is regulating in constant current mode. If the output drops below 3 V , the

IC assumes an output fault has occurred and disables the output for 3 s . This is the HICCUP state. After 3s, the state machine goes to RST and restarts. If a short or high current fault is present after the restart, the IC cycles back to HICCUP and RST. This cycle continues indefinitely until the converter is disabled or the fault is removed.

## Input Current Regulation

At all times during operation, the IC monitors the current across the input current sense resistor (ISRP and ISRN) to provide input current protection. This provides compatibility with USB input current limitations and avoids over loading weak input voltage sources.

Figure 10 shows that the input current limiting circuitry is identical to the output current setting circuitry. When the input current reaches current limit, the ACT510x control circuitry starts regulating the maximum input current. This can cause the output voltage to drop if the load resistance continues to decrease. The maximum allowable input current is 5A. The actual input current limit, lin_Lim can be scaled to $150 \%$ or $200 \%$ of lІІмм. The following equation defines the final input current limit.

$$
I_{I N_{-} L I M}=I_{I L I M} * I N P U T_{-} I L I M[1: 0]
$$

Where lilim is the hardware programmed current limit and INPUT_ILIM[1:0] is the scaling factor. INPUT_ILIM can be $150 \%$ or $200 \%$ of ІІıм. When INPUT_ILIM is programmed to 00, input current limiting is disabled.


Figure 10: Input Current Circuitry
The current sense resistor and ILIM resistor set the lııм current.

$$
I_{I L I M}=\frac{1000 \frac{V^{2}}{A}}{R_{\text {ILIM }} * R_{C S_{I} I N}}
$$

Where RІІм is the resistor from the ILIM pin to AGND and $R_{C S \_} \mathbb{N}$ is the current sense resistor value in ohms. The term $1000 \mathrm{~V}^{\wedge} 2 / \mathrm{A}$ is a constant with the units volts^2/Ampere.

The current sense resistor, Rcs_in, has the same limitations as Rcs_out. At lower maximum input currents, additional RC compensation must be placed in parallel with $\mathrm{RiLIм}$. Table 4 is also valid for the input current limit circuitry.

The input current limit circuitry, RISRP $=$ RISRN $=30.1 \mathrm{ohm}$ and $\mathrm{C}_{\text {ISR }}$ also have the same input filter requirements as the output current circuitry.

The actual input current can also be externally measured with the ILIM pin. The ILIM voltage is directly proportional to the input current. The following equation calculates the actual input current.

$$
I_{I N}=I_{I L I M} \frac{V_{I L I M}}{2 V}
$$

Table 5: $I^{2} \mathrm{C}$ Input Current Limit Setting

| INPUT_ILIM[1:0] <br> Register Setting | Input Current <br> Scaling Factor |
| :--- | :--- |
| 00 | Disabled |
| 01 | $150 \%$ of IILIM |
| 10 | $200 \%$ of IILIM |
| 11 | $150 \%$ of IILIM |

## VOUT Over-Voltage Protection

To detect a possible plug in of a higher voltage supply on VOUT, the IC detects an overvoltage condition on VOUT and immediately stops switching. The output overvoltage threshold is fixed at $108 \%$ of the programmed output voltage. If the OV condition lasts for more than 100ms, the IC exits POWER ON Mode and enters HIZ Mode.

## Cord Compensation

ACT510x provides cord compensation at the output. This feature compensates for system level voltage drops due to PCB, connector, and wiring resistances. These resistances reduce the output voltage at the load.
The ACT510x features Cord Compensation which allows the user to compensate for these system level resistances by increasing the voltage regulation set point proportional to the output current. The output voltage increases linearly with increasing load current. The $I^{2} \mathrm{C}$ CORD_COMP[1:0] bits in register 0x0F set the Cord Comp value.

The Cord Compensation value is normalized to Rcs_out $=10 \mathrm{~m} \Omega$ and a 2.4 A load current. It scales linearly with changes in current sense resistance or load current.
$V_{\text {Cord_Comp }}=V_{\text {CORD_COMP }} * \frac{I_{\text {OUT }}}{2.4 A} * \frac{R_{\text {CS_OUT }}}{0.01 \Omega}$

Where Vcord_comp is the $I^{2} \mathrm{C}$ Cord Compensation value of $100 \mathrm{mV}, 200 \mathrm{mV}$, or 300 mV per Table 6 , lout is the actual output current in Amperes, and Rcs_out is the current sense value in Ohms.

Table 6: Cord Comp Setting

| CORD_COMP[1:0] <br> Setting | Cord Comp <br> Value | Equivalent <br> System <br> Resistance |
| :---: | :---: | :---: |
| 00 | 0 (Disabled) | $0 \mathrm{~m} \Omega$ |
| 01 | 100 mV | $41.7 \mathrm{~m} \Omega$ |
| 10 | 200 mV | $83.3 \mathrm{~m} \Omega$ |
| 11 | 300 mV | $125.0 \mathrm{~m} \Omega$ |

## Light Load Disable

The ACT510x includes a Light Load Disable function. This function maximizes battery life when the IC is powered from a battery. It turns off the output and puts the IC into HIZ mode when the load drops very low. This condition typically happens when the ACT510x output supplies power to a charging portable device. When the portable device is fully charged, the output current drops to 0A. Light Load Disable minimizes battery current (the input to the ACT510x) consumption and extends battery life when the output is not needed.

Light Load Disable is available when the IC is operating in buck mode, VIN is higher than VOUT by a minimum of 0.5 V , and the Output Voltage is less than 6 V . Enable Light Load Disable by setting ${ }^{2} \mathrm{C}$ bit OFF_LOAD_EN in register $0 \times 0 E h=1$. Setting this bit $=0$ disables the feature. The minimum current is set to 5 mA typical. The current must be low for longer than the time set in $I^{2} \mathrm{C}$ bit OFF_DLY[1:0]. This time can programmed to 10s, 20s, or 30s.

Once the state machine has detected a light load condition, it enters the LL_DIS state. The IC must exit POWER ON mode and re-enter POWER ON mode to restart the converter. This is typically accomplished by toggling the EN pin, but can also be accomplished via $\mathrm{I}^{2} \mathrm{C}$.

## Output Voltage DVS (ACT5101 only)

The ACT5101 is ideally suited for many industry standard charging protocols such as USB PD3.0, QC2.0,

QC3.0, etc. This includes USB PD3.0 + PPD. To achieve this compatibility, the output voltage can be dynamically changed. VOUT in can be dynamically changed by writing to the VOUT[10:0] register. The OUTPUT_SLEW[1:0] register controls the slew rate between settings when the VOUT[10:0] is changed. When the voltage is increased, the internal ramp and regulator can compensate and increase the voltage. However, when the voltage is decreased, and there is no external load on the output, the output voltage may not decrease fast enough to the meet the requirements. To speed up the transition time from higher to lower output voltages, set PULLDOWN_RAMP=1. This turns on an internal 70 mA load when the output voltage is stepped to a lower voltage using the VOUT[10:0] register. The 70 mA load turns off when the voltage goes into regulation.

The ACT5101 also has a pulldown current that goes active during any output overvoltage condition. Enable this feature by setting the $I^{2} \mathrm{C}$ bit PULLDOWN_OV = 1 .

## POWER ON State Machine Status

The ${ }^{2} \mathrm{C}$ bits STATUS[2:0] in register $0 \times 20 \mathrm{~h}$ provide the user with real time status of the POWER ON state machine. These bits are always 000 when the IC is not in POWER ON mode.

Table 7: POWER ON State Machine Status

| STATUS[2:0] | State Machine <br> State |
| :--- | :--- |
| 000 | RST |
| 001 | SS |
| 010 | HICCUP |
| 011 | LL_DIS |
| 100 | Not Valid |
| $101-111$ |  |

## Frequency

The ACT510x can operate at $125 \mathrm{kHz}, 250 \mathrm{kHz}, 500 \mathrm{kHz}$, or 1 MHz . The switching frequency is set by the factory and is not user programmable. The default frequency is 500 kHz to give the best tradeoff between size and efficiency, but can be programmed to the other options with a custom CMI. Note that the external component value requirements change with different switching frequencies. Contact sales@active-semi.com for additional information about other configurations.

## Input Capacitor Selection

The input is connected directly to the VIN pins. The capacitor should be dedicated high quality, low-ESR, ceramic capacitor that is optimally placed to minimize the power routing. 22uF to 47 uF capacitors are typically acceptable, but the final value is application dependent. Choose the input capacitor value to keep the input voltage ripple less than $\sim 50 \mathrm{mV}$. The $\mathrm{C}_{\mathrm{IN}}$ input capacitor can be increased without limit.

$$
\mathrm{C}_{\mathrm{IN}}=\mathrm{I}_{\mathrm{OUT}} * \frac{\frac{\mathrm{v}_{\mathrm{OUT}}}{\mathrm{v}_{\text {IN }}} *\left(1-\frac{\mathrm{v}_{\mathrm{OUT}}}{\mathrm{~V}_{\text {IN }}}\right)}{\mathrm{F}_{\text {SW }} * \mathrm{~V}_{\text {ripple }}} \text { Equation } 6
$$

Where $\mathrm{C}_{\mathrm{IN}}$ is the input capacitance in uF , lout is the output current in Amperes, Vout is the output voltage in volts, $\mathrm{V}_{\mathrm{IN}}$ is the input voltage in volts, $\mathrm{F}_{\text {sw }}$ is the switching frequency in Hz , and $\mathrm{V}_{\text {ripple }}$ is the maximum allowable input voltage ripple in volts.
If the input source is a battery, no additional capacitance is needed. If the input source is a power supply rail, adding an additional 100uF bulk electrolytic capacitor is recommended.

The ceramic capacitor PCB placement is critical. Refer to the Layout Guidelines selection and to the EVK layout for details.

Be sure to consider the input capacitor's DC bias effects. A capacitor's actual capacitance is strongly affected by its DC bias characteristics. The input capacitor is typically an X5R, X7R, or similar dielectric. Use of Y5U, Z5U, or similar dielectrics is not recommended. Input capacitor placement is critical for proper operation. The input capacitor must be placed as close to the IC as possible. The traces from VBAT to the capacitor and from the capacitor to PGND should as short and wide as possible.

## Output Capacitor Selection

The output capacitors are connected directly to VOUT. The output capacitance must be a combination of ceramic and bulk capacitance.

Table 8 gives the required capacitor values for stability. Note that the table has two output capacitor options: Standard Capacitance and Minimum Capacitance. The Standard Capacitance design requires more overall capacitance, but places no restriction on the bulk capacitor ESR. The Minimum Capacitance design results in an overall smaller design, but places restrictions on the ESR. The capacitor values can be increased without limit.

Note that the Ceramic and Bulk capacitor values are recommended "Capacitor Values". When choosing the ceramic capacitors, use X5R or X7R dielectrics and be sure to consider the capacitor's tolerance and DC bias
effects. Use of Y5U, Z5U, or similar dielectrics is not recommended. The 22uF capacitor must have at least $9 u F$ of effective capacitance for stability. The 47uF capacitor must have 19uF of capacitance. The bulk capacitors do not have DC bias effects.

Output ceramic capacitor placement is critical for proper operation. The output capacitor must be placed as close to the IC as possible. The traces from VOUT to the capacitor and from the capacitor to PGND should as short and wide as possible. The bulk capacitor should be placed to the right of the current sense resistor. Refer to the Layout Guidelines selection and to the EVK layout for additional details.

## Inductor Selection

The buck-boost regulator utilizes current-mode control and a proprietary compensation scheme to simultaneously compensate the buck, buck-boost, and boost modes of operation. The ACT510x compensation requires a fixed inductor value that is matched to the switching frequency. Table 8 gives the required inductor value. Choose an inductor with a low DC-resistance, and avoid inductor saturation by choosing inductors with DC ratings that exceed the maximum output current by at least $30 \%$. The inductor value must be within $+30 \%$ to $-30 \%$ across all operating conditions.

## Compensation

The ACT510x operates in three switching modes: buck, buck-boost, and boost mode depending on the input and output voltage ratios. The IC contains a proprietary compensation scheme to simultaneously compensate all three switching modes. The compensation values are directly tied to the switching frequency and required
inductor value. Table 8 provides the required compensation values when the IC can operate in all three switching modes Table 9 provides optimized compensation values when the IC will only be operating in Buck mode. Figure 11 shows the compensation components

Be sure to consider the input capacitor's DC bias effects. A capacitor's actual capacitance is strongly affected by its DC bias characteristics. The input capacitor is typically an X5R, X7R, or similar dielectric. Use of Y5U, Z5U, or similar dielectrics is not recommended.

Input capacitor placement is critical for proper operation. The input ceramic capacitor must be placed as close to the IC as possible. The traces from VIN to the capacitor and from the capacitor to PGND should as short and wide as possible. Refer to the Layout Guidelines selection and to the EVK layout for details.

The bulk capacitor should be placed on the left side of the current sense resistor.


Figure 11: Compensation

Table 8: Inductor and Compensation - Buck, Buck-boost, and Boost Modes

|  |  |  |  |  | Standard Capacitance Design |  |  | Minimum Capacitance Design |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Switching Frequency | Inductor Min / Typ / Max (uH) | CICOMP1 ( nF ) | $\mathrm{C}_{\text {ICOMP2 }}$ (nF) | $\begin{aligned} & \mathrm{R}_{\mathrm{ICoMP}} \\ & (\mathrm{k} \Omega) \end{aligned}$ | Ceramic Capacitor (uF) | Bulk <br> Capacitor (uF) | Bulk Capacitor ESR ( $\mathrm{m} \Omega$ ) | Ceramic Capacitor (uF) | Bulk <br> Capacitor (uF) | Bulk Capacitor ESR ( $\mathrm{m} \Omega$ ) |
| 125Khz | 29 / 42 / 55 | 82 | 8.2 | 20.0 | 47 | 1000 | N/A | 22 | 470 | 30-100 |
| 250Khz | $15 / 22$ / 29 | 39 | 3.9 | 20.0 | 47 | 470 | N/A | 22 | 220 | 50-200 |
| 500 KHz | $7 / 10$ / 13 | 22 | 2.2 | 20.0 | 47 | 220 | N/A | 22 | 100 | 50-200 |
| 1MHZ | 4 / 5.6 / 7.28 | 10 | 1.0 | 20.0 | 47 | 100 | N/A | 22 | 100 | 50-200 |

Table 9: Inductor and Compensation - Buck Mode Only

|  |  |  |  |  | Standard Capacitance Design |  |  | Minimum Capacitance Design |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Switching Frequency | Inductor Min / Typ / Max (uH) | $\mathrm{C}_{\text {Icomp1 }}$ ( nF ) | $\mathrm{C}_{\text {Icomp2 }}$ (nF) | $\begin{gathered} R_{\text {ICoMP }} \\ (k \Omega) \end{gathered}$ | Ceramic Capacitor (uF) | Bulk Capacitor (uF) | Bulk Capacitor ESR ( $\mathrm{m} \Omega$ ) | Ceramic Capacitor (uF) | Bulk <br> Capacitor (uF) | Bulk Capacitor ESR ( $\mathrm{m} \Omega$ ) |
| 125Khz | 25.2 / 42 / 50.4 | 8.2 | 0.82 | 100 | 47 | 1000 | N/A | 22 | 470 | 30-100 |
| 250Khz | 13.2/22/26.4 | 3.9 | 0.39 | 100 | 47 | 470 | N/A | 22 | 220 | 50-200 |
| 500 KHz | 6.0/10/12.0 | 2.2 | 0.22 | 100 | 47 | 220 | N/A | 22 | 100 | 50-200 |
| 1MHZ | $3.36 / 5.6 / 6.72$ | 1 | 0.1 | 100 | 47 | 100 | N/A | 22 | 100 | 50-200 |

## ADC Monitoring

## General Description

The ACT510x contains a built-in analog to digital converter, ADC, which can be used to monitor six system level parameters. These include input voltage, output voltage, input current, output current, die temperature, and the external ADC input pin. It uses a single 12 bit delta-sigma ADC that uses an analog input multiplexer to select one of seven channels for the A/D conversion. The resulting digital results are stored in seven digital registers. A seven to one multiplexer connects one of the ADC output registers to the user accessible register map.

## ADC Configuration

The ACT510x ADC is configured through the $I^{2} C$ interface. It is enabled and disabled by the $I^{2} \mathrm{C}$ bit EN_ADC in register 0x09h. The ADC has two conversion modes, manual single-shot conversion and automatic polling conversion.

## Single-Shot Conversion

Configure the IC for single-shot conversion mode by setting the following $\mathrm{I}^{2} \mathrm{C}$ bits in register $0 \times 09 \mathrm{~h}$

```
ADC_ONE_SHOT = 1.
ADC_CH_SCAN = 0
DIS_ADCBUF = 0
```

In single shot mode, the user defines the input channel to be converted and then manually initiates the ADC conversion. ${ }^{2} \mathrm{C}$ bits ADC_CH_CONV [2:0] in register $0 x 0 A h$ select the input channel to be converted. ADC_CH_READ [2:0] selects the ADC channel to be read. These should be set to the same channel. The user initiates an ADC read by writing a 1 into EN_ADC in register $0 \times 09 \mathrm{~h}$. When ADC conversion is complete, the ADC_DATA_READY bit in register 0x0Ah is set to $1, \mathrm{nIRQ}$ is asserted low, and EN_ADC bit automatically changes back to 0 . The uP can then read the status bits to find that the ADC conversion is complete. The ADC data are stored in ADC_OUT [13:6] in register 0x07h and ADC_OUT[5:2] in register 0x08h. nIRQ stays asserted low and the ADC_READY_BIT stays equal to 1 until the ADC data is read. Reading the ADC data automatically deasserts nIRQ. To initiate another ADC conversion for the same channel, set EN_ADC=1. To initiate an ADC conversion for another channel, change ADC_CH_CONV and ADC_CH_READ to the appropriate channel and then set EN_ADC=1.


Figure 12: ADC Block Diagram

## Automatic Polling Conversion

Configure the IC for automatic polling conversion mode by setting the following $\mathrm{I}^{2} \mathrm{C}$ bits in register $0 \times 09 \mathrm{~h}$

ADC_ONE_SHOT = 0
ADC_CH_SCAN = 1
DIS_ADCBUF $=0$

Start the automatic polling by changing EN_ADC to 1. When in automatic polling mode, the ADC continuously changes the MUX inputs to read all input channels. The ADC continually overwrites the data in the output register. After all channels have been converted, the ADC_DATA_READY bit is set to 1 . Note that nIRQ is not asserted low in Automatic Polling mode. Ensure that ADC data is valid and ready by reading the ADC_DATA_READY before reading ADC data. After the ADC_DATA_READY bit is set to 1, the user defines the channel to be read with the ADC_CH_READ [2:0] bits in register 0x0Ah. Change ADC_CH_READ [2:0] to read additional channels.

Table 10 shows the equations to convert the ADC data into the actual measured values. Note that the klim term in the Input Current measurement depends on the IC's INPUT_ILIM register setting ( ${ }^{2} \mathrm{C}$ register $0 \times 10 \mathrm{~h}$ ). Table 11 shows how to determine the correct klim value.

Table 10: ADC Channels

| Channel | Channel Description | ADC_CH_CONV[2:0] | ADC_CH_READ[2:0] | Value |
| :---: | :---: | :---: | :---: | :---: |
| CHO | Output Current (OLIM) | 000 | 000 | $\begin{gathered} \hline \text { lout }=0.7633^{*} \text { (ADC_OUT[13:2]- } \\ \text { 2048)/Rcs_out/Rolim } \end{gathered}$ |
| CH1 | Output Voltage (VOUT) | 001 | 001 | Vout $=0.01527^{*}$ (ADC_OUT-2048) |
| CH2 | Input Voltage (VIN) | 010 | 010 | VIN $=0.02035 *$ (ADC_OUT-2048) |
| CH3 | Input Current (ILIM) | 011 | 011 | $\begin{gathered} \mathrm{IIN}_{\mathrm{N}}=\text { klim*}^{*} 0.7633^{*}(\text { ADC_OUT[13:2]- } \\ \text { 2048)/RCS_IN/RIIIM } \end{gathered}$ |
| CH4 | n/a | 100 | 100 | n/a |
| CH5 | Die Temperature | 101 | 101 | TJ $=0.2707 *$ ADC_OUT[13:2] - 809.49 |
| CH6 | ADC Input | 110 | 110 | $V_{\text {ADC }}=0.01527^{*}\left(A D C \_O U T[13: 2]-2048\right)$ |

Table 11: klim Values

| IC Operating <br> Mode | OTG_BAT_ILIM <br> (register 0x10h) | klim |
| :---: | :---: | :---: |
| OTG | 00 | disabled |
|  | 01 | 1.5 |
|  | 10 | 2.0 |
|  | 11 | 1.5 |

Below is an example ADC read.
Input current $=2.0 \mathrm{~A}$. Assume Rcs_ın $=0.01$ ohm and RІІм $=33.1 \mathrm{kohm}$. Also assume the INPUT_ILIM register $=10$. This register sets klim = 2

Read CH 3 to measure the input current. This reading results in the ADC_OUT[13:2] $=0 \times 9 A 4 h$, which converts to 2468 decimal.

$$
I_{I N}=\frac{k l i m * 0.7633 *(2468-2048)}{0.01 * 33100}=1.937 A
$$

## PC board layout guidance

Proper parts placement and PCB layout are critical to the operation of switching power supplies. Follow the following layout guidelines when designing the ACT510x PCB. Refer to the Active-Semi ACT510x Evaluation Kit for layout guidance.

1. Place the ceramic input and output capacitors as close as possible to the IC. Connect the input capacitors directly between VIN and PGND pins on the top layer. Connect the output capacitors directly between VOUT and PGND pins on the top layer. Use 1206 sized capacitors to allow for proper switch pin routing. Note that the input and output capacitor placement is critical. Active-Semi strongly recommends following the EVK input capacitor and output capacitor placement and routing. The bulk input and output capacitor placement is not as critical. Bulk capacitors should be placed on the opposite side of the sense resistors from the ceramic capacitors.
2. Minimize the switch node trace lengths between the SW1 and SW2 pins and the inductor. Optimal switch node routing is to run the traces between the input and output capacitors' pads. Using 1206 or larger sized capacitors is recommended. Avoid routing sensitive analog signals near these high frequency, high $\mathrm{dV} / \mathrm{dt}$ traces Active-Semi strongly recommends following the EVK inductor placement and PCB routing.
3. The VINS pin should be Kelvin connected to the input capacitors. Keep this trace away from the SW1 and SW2 traces to prevent noise injection. The IC uses this pin to measure the input voltage.
4. The PGND and AGND ground pins must be electrically connected together. The AGND ground plane should be isolated from the rest of the PCB power ground. These two ground
pins should be connected together right at the IC.
5. Connect the exposed pad directly to the top layer PGND pins and ground plane. Connect the top layer ground plane to both internal ground planes and the PCB backside ground plane with thermal vias. Provide ground plane routing on multiple layers to allow the IC's heat to flow into the PCB and then spread radially from the IC. Avoid cutting the ground planes or adding vias that restrict the radial flow of heat.
6. Make Kelvin connections to the ILIM and OLIM current sense resistors. Route the current sense signals close to each other and keep them away from noisy switching signals.
7. The current sense filter capacitors and inductors should be placed directly by their respective ISRP, ISRN, OSRP, and OSRN pins.
8. Remember that all open drain outputs need pull-up resistors.
9. The following components should be connected to the AGND plane.

ILIM resistor
OLIM resistor
COMP resistor and capacitors
VREG bypass capacitor
INTBP bypass capacitor
10. The ACT510x footprint must connect the VOUT pins 23,24 , and 35 on the top layer. It must connect the SW1 pins 21, 22, and 34 on the top layer. It must connect the SW2 pins 18, 19, and 33 on the top layer.

## Typical Operating Characteristics

CMI 102

$200 \mathrm{~ms} /$ div

CMI 102


CMI 102


$1 \mathrm{~ms} / \mathrm{div}$

CMI 102

$1 \mathrm{~ms} / \mathrm{div}$

CMI 102

$2 \mathrm{~s} / \mathrm{div}$

Solutions for Sustainability


CMI 102


CMI 102


CMI 102
VOUT Step - 5 V to 9 V

$2 \mathrm{~ms} /$ div

CMI 102
VOUT Step - 5 V to 20 V

$10 \mathrm{~ms} / \mathrm{div}$

CMI 102
VOUT Step - 20V to 9 V
VIN=7.4V, $10 \mathrm{UT}=2 \mathrm{~A}$ TOC-012


CMI 102


CMI 102


1us / div

$10 \mathrm{~s} / \mathrm{div}$

CMI 102


2us / div

CMI 102


2us / div



200us / div


CMI 102

$40 \mathrm{~ms} / \mathrm{div}$

## CMI OPTIONS

This section provides the basic default configuration settings for each available ACT510x CMI option.
CMI 102: ACT5101QI102
CMI 102 has default settings that are appropriate for most typical applications. It operates with a 500kHz switching frequency to provide an optimal tradeoff between overall size and efficiency. The table below shows the default register settings.

| Function | ACT5101Q1102 Default Register Settings | Register |
| :---: | :---: | :---: |
| Converter |  |  |
| Default Output Voltage | 5.1V | VOUT |
| Output Constant Current Control | Enabled | DIS_CC |
| Output Constant Current Limit Scaling Factor (relative to lolim) | 100\% | CC |
| Input Constant Current Limit Scaling Factor (relative to llıim) | 200\% | INPUT_ILIM |
| Softstart Time | 5 ms | SOFT_START |
| Switching Frequency | 500kHz | FREQ_SEL |
| EN Pin Polarity | Active High | EN_POLARITY |
| Start up Delay | Oms | EN_DLY |
| Cord Compensation | 200 mV | CORD_COMP |
| VIN_UV_OFFSET register setting | 5.0 V | VIN_UV_OFFSET |
| VIN_UV register setting | 1.4 V | VIN_UV |
| VIN UV Voltage | 3.6 V | VIN_UV and VIN_UV_OFFSET |
| Output Slew Rate | $0.5 \mathrm{~V} / \mathrm{ms}$ | OUTPUT_SLEW |
| PFM Mode | Enabled | DIS_PFM |
| Light Load Turn Off | Disabled | OFF_LOAD_EN |
| Light Load Turn Off Delay | 30s | OFF_DLY |
| OCP Shutdown (8 FET OC cycles) | Enabled | DIS_OCP_SHUTDOWN |
| FET cycle by cycle current limit | 10A | FET_ILIMIT \& ILIM_LOW |
| STAT Pin Functionality | Enabled | EN_STAT |
| ADC |  |  |
| ADC Enabled | Disabled | EN_ADC |
| VREG LDO |  |  |
| VREG Enabled | Enabled | VREG_EN |
| VREG Output Voltage | 5 V | VREG |
| VREG Input Control | Auto | VREG_OVERRIDE |
| VREG Input Voltage | VOUT | VREG_SELECT |
| VREG Fault Disables VOUT | Yes | DIS_VREG_FLT |
| Miscellaneous |  |  |
| Watchdog Timer | Disabled | WATCHDOG |
| Die Regulation Temperature | 120 deg C | TREG |
| 7-bit I2C Slave Address | 0x24h | I2CADD |

## CMI 103: ACT5101QI103

CMI 103 has default settings that are appropriate for most typical applications. It operates with a 500kHz switching frequency to provide an optimal tradeoff between overall size and efficiency. The table below shows the default register settings. The difference between ACT5101QI102 and ACT5101QI103 is the 7-bit I² address. The ACT5101QI103 address changes to $0 \times 66 \mathrm{~h}$.

| Function | ACT5101Q103 Default Register Settings | Register |
| :---: | :---: | :---: |
| Converter |  |  |
| Default Output Voltage | 5.1V | VOUT |
| Output Constant Current Control | Enabled | DIS_CC |
| Output Constant Current Limit Scaling Factor (relative to lolim) | 100\% | CC |
| Input Constant Current Limit Scaling Factor (relative to IILIM) | 200\% | INPUT_ILIM |
| Softstart Time | 5 ms | SOFT_START |
| Switching Frequency | 500 kHz | FREQ_SEL |
| EN Pin Polarity | Active High | EN_POLARITY |
| Start up Delay | Oms | EN_DLY |
| Cord Compensation | 200 mV | CORD_COMP |
| VIN_UV_OFFSET register setting | 5.0 V | VIN_UV_OFFSET |
| VIN_UV register setting | 1.4 V | VIN_UV |
| VIN UV Voltage | 3.6 V | VIN_UV and VIN_UV_OFFSET |
| Output Slew Rate | $0.5 \mathrm{~V} / \mathrm{ms}$ | OUTPUT_SLEW |
| PFM Mode | Enabled | DIS_PFM |
| Light Load Turn Off | Disabled | OFF_LOAD_EN |
| Light Load Turn Off Delay | 30s | OFF_DLY |
| OCP Shutdown (8 FET OC cycles) | Enabled | DIS_OCP_SHUTDOWN |
| FET cycle by cycle current limit | 10A | FET_ILIMIT \& ILIM_LOW |
| STAT Pin Functionality | Enabled | EN_STAT |
| ADC |  |  |
| ADC Enabled | Disabled | EN_ADC |
| VREG LDO |  |  |
| VREG Enabled | Enabled | VREG_EN |
| VREG Output Voltage | 5 V | VREG |
| VREG Input Control | Auto | VREG_OVERRIDE |
| VREG Input Voltage | VOUT | VREG_SELECT |
| VREG Fault Disables VOUT | Yes | DIS_VREG_FLT |
| Miscellaneous |  |  |
| Watchdog Timer | Disabled | WATCHDOG |
| Die Regulation Temperature | 120 deg C | TREG |
| 7-bit I2C Slave Address | 0x66h | I2CADD |

## CMI 102: ACT5102QI102

CMI 102 has default settings that are appropriate for most typical applications. It operates with a 500kHz switching frequency to provide an optimal tradeoff between overall size and efficiency. The table below shows the default register settings. The difference between the ACT5101QI102 and ACT5102QI102 is that the ACT5102QI102 has external voltage feedback and does not have the ADC functionality.

| Function | ACT5102Q1102 Default Register Settings | Register |
| :---: | :---: | :---: |
| Converter |  |  |
| Default Output Voltage | 5.1V | VOUT |
| Output Constant Current Control | Enabled | DIS_CC |
| Output Constant Current Limit Scaling Factor (relative to loum) | 100\% | CC |
| Input Constant Current Limit Scaling Factor (relative to lıім) | 200\% | INPUT_ILIM |
| Softstart Time | 5 ms | SOFT_START |
| Switching Frequency | 500 kHz | FREQ_SEL |
| EN Pin Polarity | Active High | EN_POLARITY |
| Start up Delay | Oms | EN_DLY |
| Cord Compensation | 200 mV | CORD_COMP |
| VIN_UV_OFFSET register setting | 5.0 V | VIN_UV_OFFSET |
| VIN_UV register setting | 1.4 V | VIN_UV |
| VIN UV Voltage | 3.6 V | VIN_UV and VIN_UV_OFFSET |
| Output Slew Rate | $0.5 \mathrm{~V} / \mathrm{ms}$ | OUTPUT_SLEW |
| PFM Mode | Enabled | DIS_PFM |
| Light Load Turn Off | Disabled | OFF_LOAD_EN |
| Light Load Turn Off Delay | 30s | OFF_DLY |
| OCP Shutdown (8 FET OC cycles) | Enabled | DIS_OCP_SHUTDOWN |
| FET cycle by cycle current limit | 10A | FET_ILIMIT \& ILIM_LOW |
| STAT Pin Functionality | Enabled | EN_STAT |
| ADC |  |  |
| n/a | n/a | n/a |
| VREG LDO |  |  |
| VREG Enabled | Enabled | VREG_EN |
| VREG Output Voltage | 5 V | VREG |
| VREG Input Control | Auto | VREG_OVERRIDE |
| VREG Input Voltage | VOUT | VREG_SELECT |
| VREG Fault Disables VOUT | Yes | DIS_VREG_FLT |
| Miscellaneous |  |  |
| Watchdog Timer | Disabled | WATCHDOG |
| Die Regulation Temperature | 120 deg C | TREG |
| 7-bit I2C Slave Address | 0x24h | I2CADD |

## I2C REGISTERS

The register map section provides a basic understanding of the ACT510x registers. Note that the default values reference the ACT5101 CMI 102 settings.

| Register | Register Name | Type | R/W | Description | Default |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $0 \times 00$ | Master Control 1 | VM | R/W | Configure various device options | 0x00h |
| $0 \times 01$ | Master Control 2 | NVM | R/W |  | 0xB4h |
| $0 \times 02$ | General Status | VM | R | Device status | 0x00h |
| $0 \times 03$ | Thermal Status | VM | R | Thermal status | 0x00h |
| 0x04 | RFU | VM | R | Reserved for future use | 0x00h |
| 0x05 | Fault 1 | VM | R | Device Faults | 0x00h |
| 0x06 | Fault 2 | VM | R |  | 0x00h |
| $0 \times 07$ | ADC Output 1 | VM | R | ADC Output | 0x00h |
| $0 \times 08$ | ADC Output 2 | VM | R |  | 0x00h |
| $0 \times 09$ | ADC Configuration 1 | VM | R/W | ADC configuration bits | 0x00h |
| 0x0A | ADC Configuration 2 | VM | R/W |  | 0x00h |
| 0x0B | VREG Control | NVM | R/W | Configure VREG Input Source | 0x80h |
| 0x0C | RFU | NVM | R/W | Reserved for future use | 0x10h |
| 0x0D | RFU | NVM | R/W | Reserved for future use | 0x08h |
| 0x0E | Converter Control 1 | NVM | R/W | Configure Converter Operation | 0xA2h |
| 0x0F | Converter Control 2 | NVM | R/W | Configure Converter Operation | 0xF8h |
| $0 \times 10$ | Converter Control 3 | NVM | R/W | Configure Converter Operation | 0x78h |
| $0 \times 11$ | VREG Voltage | NVM | R/W | 5bit, $2.0 \sim 5.1 \mathrm{~V}, \mathrm{LSB}=100 \mathrm{mV}$, Default $=5 \mathrm{~V}$ | 0xF6h |
| $0 \times 12$ | RFU | NVM | R/W | Reserved for future use | 0xA4h |
| $0 \times 13$ | Output Voltage 1 | NVM | R/W | 10-bit, $3.0 \sim 23.42 \mathrm{~V}, \mathrm{LSB}=10 \mathrm{mV}$, Default $=5.1 \mathrm{~V}$ | 0xA0h |
| 0x14 | Output Voltage 2 | NVM | R/W |  | 0xD6h |
| $0 \times 15$ | RFU | NVM | R/W | Reserved for future use | 0x80h |
| $0 \times 16$ | RFU | NVM | R/W | Reserved for future use | 0x80h |


| $0 \times 17$ | Output Current Limit | NVM | R/W | 7-bit, $0 \sim 100 \%$, LSB $=1 \%$, Default $=100 \%$ | $0 \times 64 \mathrm{~h}$ |
| :---: | :--- | :---: | :---: | :--- | :--- |
| $0 \times 18$ | RFU | NVM | R/W | Reserved for future use | $0 \times 64 \mathrm{~h}$ |
| $0 \times 19$ | RFU | NVM | R/W | Reserved for future use | $0 \times 00 \mathrm{~h}$ |
| $0 \times 1$ A | VIN UV | NVM | R/W | 8-bit, $2.5 \sim 15.2 \mathrm{~V}$, LSB $=100 \mathrm{mV}$, default $=3 \mathrm{~V}$ | $0 \times 00 \mathrm{~h}$ |
| $0 \times 1 \mathrm{~B}$ | RFU | NVM | R/W | Reserved for future use | $0 \times 40 \mathrm{~h}$ |
| $0 \times 1 \mathrm{C}$ | RFU | NVM | R/W | Reserved for future use | $0 \times 40 \mathrm{~h}$ |
| $0 \times 1 \mathrm{D}$ | Frequency | NVM |  |  | $0 \times 83 \mathrm{~h}$ |
| $0 \times 1 \mathrm{E}$ | IRQ Control 1 | VM | R/W |  | $0 \times 00 \mathrm{~h}$ |
| $0 \times 1 F$ | IRQ Control 2 | VM | R/W |  | $0 \times 00 \mathrm{~h}$ |
| $0 \times 20$ | VOUT Status | VM | R | IRQ Mask Control / Converter Status | $0 \times 00 \mathrm{~h}$ |

## REG 0x00: Main Control 1 (R/W) (VM)

| Bit |  | Name |  | Comment |
| :---: | :--- | :---: | :--- | :--- | (

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## REG 0x01: Main Control 2 (R/W) (NVM)

| Bit | Name |  | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7 | RFU | 1 |  | Reserved for future use. Do not change. |
| 6 | DIS_SHUTDOWN | 0 | 0: Enable <br> 1: Disable | If set to 0 , the device will be disabled if FET cycle by cycle current limit is detected for 8 (or 16) continuous cycles. Uses the FET_LIMIT register setting for the FET current limit. |
| 5 | RFU | 1 |  | Reserved for future use. Do not change. |
| 4 | FET_ILIMIT | 1 | $\begin{aligned} & \text { 0: 8.5A } \\ & \text { 1: } 10 \mathrm{~A} \end{aligned}$ | This is the peak cycle-by-cycle current limit setting for ALL FETS in any operating mode: |
|  | RFU | 0 |  | Reserved for future use. Do not change. |
| 2 | VREG_EN | 1 | 0: Turn OFF VREG <br> 1: Turn ON VREG | Control VREG on/off Default is on. |
| 1 | WATCHDOG[1] | 0 | 00: Disable timer <br> 01: 80s | I2C Watchdog Timer Setting <br> Watchdog timer is always disabled and reset to 0 in HIZ Mode. |
| 0 | WATCHDOG[0] | 0 | $\begin{aligned} & \text { 10: } 160 \mathrm{~s} \\ & \text { 11: } 320 \mathrm{~s} \end{aligned}$ |  |

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## REG 0x02: General Status (Read Only) (VM)

| Bit | Name |  | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7 | RFU | 0 |  | Reserved for future use. Do not change. |
| 6 | nIRQ_PIN_Status | 0 | 0 : nIRQ is pulled to ground (logic 0) <br> 1: nIRQ pin is open collector (logic 1) | Real-time nIRQ status. <br> Note that nIRQ is open collector, so the output can be pulled to ground by an external circuit even if this bit $=1$ to indicate a high impedance state. |
| 5 | EN_PIN_STATUS | 0 | 0: EN Pin Low <br> 1: EN Pin High | Real time status of the EN pin |
| 4 | RFU | 0 |  | Reserved for future use. Do not change. |
| 3 | RFU | 0 |  | Reserved for future use. Do not change. |
| 2 | RFU | 0 |  | Reserved for future use. Do not change. |
| 1 | OPERATION_MODE[1] | 0 | 00: HIZ State <br> 01: not valid | Current state machine status for overall system |
| 0 | OPERATION_MODE[0] | 0 | 10: POWER ON State <br> 11: not valid |  |

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## REG 0x03: Thermal Status (Read only) (VM)

| Bit | Name |  | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7 | RFU | 0 |  | Reserved for future use. Do not change. |
| 6 | THERMAL_ACTIVE | 0 | 0 : Not in thermal regulation <br> 1: Thermal regulation Active | Thermal Regulation Active |
| 5 | RFU | 0 |  | Reserved for future use. Do not change. |
| 4 | RFU | 0 |  | Reserved for future use. Do not change. |
| 3 | RFU | 0 |  | Reserved for future use. Do not change. |
| 2 | RFU | 0 |  | Reserved for future use. Do not change. |
| 1 | RFU | 0 |  | Reserved for future use. Do not change. |
| 0 | RFU | 0 |  | Reserved for future use. Do not change. |

## REG 0x04: RFU (Read Only) (VM)

| Bit | Name |  | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7-0 | RFU | 0 |  | Reserved for future use. Do not change. |

REG 0x05: Faults 1 (Read only) (VM)

| Bit |  | Name |  | Comment |
| :--- | :--- | :---: | :--- | :--- |

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REG 0x06: Faults 2 (Read only) (VM)

| Bit | Name |  | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7 | WATCHDOG_FAULT | 0 | 0: No Fault <br> 1: Watchdog Fault | Watchdog Timeout Fault <br> This bit is latching. If Watchdog is enabled and watchdog timer times out, then this bit is set high. <br> This bit is not cleared when read. The watchdog timer is cleared with a watchdog read or by disabling the watchdog timer. |
| 6 | VOUT_FAULT | 0 | 0: No Fault <br> 1: VOUT Fault | Output Hiccup Mode Fault <br> This bit is latching. Read this bit to clear the value back to 0 . If the VOUT enters hiccup state because current exceeds the Constant Current Mode, then this bit gets set. <br> This register will always be set during hiccup mode when VOUT is off during the 3 sec restart time and converter is in the HICCUP state. After it exits this state, a read clears this bit. |
| 5 | VIN_UV_FLT | 0 | 0: No Fault <br> 1: VIN UV Fault | VIN UV Fault <br> This bit is latching. If VIN falls below the Vin_uv_offset Voltage specified in the VIN_UV_OFFSET Register (Reg 0x0F, Bits $7: 5$ ), this bit is set to 1 . <br> When the input voltage is above the VIN_UV_OFFSET voltage, a read will clear this fault bit. |
| 4 | VOUT_OV | 0 | 0: No Fault <br> 1: VOUT OV Fault | Vout Overvoltage Fault <br> Read to Clear latching bit <br> This bit will be set any time the Vout exceeds the OV threshold for external or internal feedback. The VOUT must be below the OV voltage and then a read will clear this fault bit. |
| 3 | LIGHT_LOAD | 0 | 0: No Fault <br> 1: Converter off | Output Light Load State Latch <br> This bit is latching. This bit is set when the converter has been disabled because of light load condition on output and it entered the LL_DIS state. After the IC exits the LL_DIS state, a read clears this bit. |
| 2 | VIN_OV | 0 | 0: No Fault <br> 1: VIN OV | VIN Overvoltage fault <br> This bit is latching. This bit is set any time VIN exceeds the OV threshold when in the POWER ON state. VIN must be below the OV voltage and then a read clears this bit. |
| 1 | I2C_FAULT | 0 | 0: No Fault <br> 1: I2C Fault | If set to 1, I2C command did not finish correctly or errors on I2C data |
| 0 | RFU | 0 |  | Reserved for future use. Do not change. |

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REG 0x07: ADC Output 1 (Read only) (VM)

| Bit | Name |  | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7 | ADC_OUT[13]/[7] | 0 |  | Selected data output from ADC_READ Register ADC output <br> Upper 8 Bits of ADC output. <br> If only 8 Bits are used, then [7:0] <br> If all 14 Bits are used, then [13:6] |
| 6 | ADC_OUT[12]/[6] | 0 |  |  |
| 5 | ADC_OUT[11]/[5] | 0 |  |  |
| 4 | ADC_OUT[10]/[4] | 0 |  |  |
| 3 | ADC_OUT[9]/[3] | 0 |  |  |
| 2 | ADC_OUT[8]/[2] | 0 |  |  |
| 1 | ADC_OUT[7]/[1] | 0 |  |  |
| 0 | ADC_OUT[6]/[0] | 0 |  |  |

REG 0x08: ADC Output 2 (Read only) (VM)

| Bit | Name | $\begin{aligned} & \frac{0}{\sqrt{n}} \\ & \frac{1}{3} \\ & \frac{5}{3} \\ & \frac{\pi}{0} \end{aligned}$ | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7 | RFU | 0 |  | Reserved for future use. Do not change. |
| 6 | RFU | 0 |  |  |
| 5 | ADC_OUT[5] | 0 |  | Selected data output from ADC_READ Register Lower 4 LSB Bits of ADC Output |
| 4 | ADC_OUT[4] | 0 |  |  |
| 3 | ADC_OUT/[3] | 0 |  |  |
| 2 | ADC_OUT[2] | 0 |  |  |
| 1 | ADC_OUT[1] | 0 |  |  |
| 0 | ADC_OUT[0] | 0 |  |  |

REG 0x09: ADC Configuration 1 (R/W) (VM)

| Bit | Name |  | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7 | EN_ADC | 0 | 0: ADC disabled <br> 1: ADC enabled |  |
| 6 | ADC_ONE_SHOT | 0 | 0 : ADC continually converts data when EN_ADC=1 <br> 1: ADC performs a onetime conversion when EN_ADC=1 | [ADC ONE SHOT][ADC_CH_SCAN] = XX operation is described as below. <br> $00=$ Scan channel specified by ADC CHANNEL CONVERSION [2:0] register bits repeatedly in a loop. <br> 01 = Scan and convert channels $0-7$ repeatedly in a loop. <br> $10=$ Convert channel specified by ADC CHANNEL <br> CONVERSION [2:0] once (one shot) <br> 11 = Scan and convert channels 0-7 once and stop - one loop |
| 5 | ADC_CH_SCAN | 0 | 0 : Scan single channel specified by ADC_CH_CONV <br> 1: Scan all channels |  |
| 4 | DIS_ADC_BUFFER | 0 | 0 : ADC Buffer is enabled <br> 1: ADC Buffer is disabled | This should always be set to 0 . |
| 3 | ADC_SWAP | 0 | 0 : ADC Buffer is normal inputs <br> 1: ADC Buffer swaps inputs | If very accurate measurements are required, the ADC input pair can be swapped to negate input offset errors in the Buffer AMP. This requires one read with $A D C$ _SWAP $=0$ and one read with $A D C \_S W A P=1$, then average the results. |
| 2 | HW_DIE_REV[2] | 0 |  | HW Die Revision <br> For use by Active Semi |
| 1 | HW_DIE_REV[1] | 0 |  |  |
| 0 | HW_DIE_REV[0] | 0 |  |  |

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## REG 0x0A: ADC Configuration 2 (R/W) (VM)

| Bit | Name |  | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7 | ADC_DATA_READY | 0 | 0 : Data not ready <br> 1: Data is ready | Read Only - Conversion occurred and data is ready to read |
| 6 | RFU | 0 |  | Reserved for future use. Do not change. |
| 5 | ADC_CH_I2C_READ[2] | 0 | $\begin{aligned} & 000=\text { OLIM Pin } \\ & 001=\text { VOUT } \end{aligned}$ | This controls the current A2D register to output on the I2C register. The A2D can provide an I2C read on a different |
| 4 | ADC_CH_I2C_READ[1] | 0 | $\begin{aligned} & 010=\text { VIN } \\ & 011=\text { ILIM } \end{aligned}$ |  |
| 3 | ADC_CH_I2C_READ[0] | 0 | $\begin{aligned} & 100=\text { not valid } \\ & 101=\text { Die temperature } \\ & 110=\text { External input } \\ & 111=\text { AGND } \end{aligned}$ |  |
| 2 | ADC_CH_CONV [2] | 0 | $\begin{aligned} & 000=\text { ILIM Pin } \\ & 001=\text { VIN } \end{aligned}$ | This controls the current A2D conversion processing channel. The A2D can provide an I2C read on a different |
| 1 | ADC_CH_CONV [1] | 0 | $\begin{aligned} & 010=\text { VBAT } \\ & 011=\text { OLIM } \end{aligned}$ | register while processing /converting another channel. |
| 0 | ADC_CH_CONV [0] | 0 | $\begin{aligned} & 100=\text { TH } \\ & 101=\text { Die temperature } \\ & 110=\text { External input } \\ & 111=\text { AGND } \end{aligned}$ |  |

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## REG 0x0B: VREG Control 1 (R/W) (NVM)

| Bit | Name | $\begin{aligned} & \frac{0}{\frac{1}{N}} \\ & \frac{2}{1} \\ & \frac{H}{J} \\ & \frac{\pi}{0} \\ & 0 \end{aligned}$ | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7 | RFU | 1 |  | Reserved for future use. Do not change. |
| 6 | RFU | 0 |  | Reserved for future use. Do not change. |
| 5 | RFU | 0 |  | Reserved for future use. Do not change. |
| 4 | RFU | 0 |  | Reserved for future use. Do not change. |
| 3 | RFU | 0 |  | Reserved for future use. Do not change. |
| 2 | RFU | 0 |  | Reserved for future use. Do not change. |
| 1 | VREG_OVERRIDE | 0 | 0: Automatic Control <br> 1: Manual Control | 0 : The IC automatically selects the correct VREG input supply <br> 1: Forces the IC to use the VREG input supply defined by the VREG_SELECT register. |
| 0 | VREG_SELECT | 0 | 0: VOUT Supply <br> 1: VIN Supply | Defines the VREG input power source. |

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## REG 0x0C: RFU (R/W) (NVM)

| Bit | Name |  | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7-0 | RFU | 0x10h |  | Reserved for future use. Do not change. |

REG 0x0D: RFU (R/W) (NVM)

| Bit | Name |  | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7-0 | RFU | 0x08h |  | Reserved for future use. Do not change. |

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REG 0x0E: Converter Control 1 (R/W) (NVM)

| Bit |  |  | Name | Comment |
| :--- | :--- | :--- | :--- | :--- |

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## REG 0x0F: Converter Control 2 (R/W) (NVM)

| Bit | Name | $\begin{aligned} & \frac{0}{\frac{3}{\pi}} \\ & N_{0}^{5} \\ & \frac{1}{7} \\ & \frac{\pi}{0} \end{aligned}$ | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7 | VIN_UV[2] | 1 | 000: VVin_uv_offset <br> 001: V Vin_uv_offset -0.2 V 010: V Vin_uv_offset -0.4 V 011: Vin_uv_offset -0.6 V 100: Vin_uv_offset -0.8 V 101: $\mathrm{V}_{\text {Vin_uv_offset }}-1.0 \mathrm{~V}$ 110: VVin_uv_offset-1.2V 111: Vin_uv_offset -1.4 V | VIN UV threshold for the converter to operate. Referenced from Vin_uv level. |
| 6 | VIN_UV[1] | 1 |  |  |
| 5 | VIN_UV[0] | 1 |  |  |
| 4 | EN_STAT | 0 | 0: Disable <br> 1: Enable | If EN_STAT bit is 1, the IC pulls the STAT pin low to indicate the converter is running. OUT fault or VIN UV, etc, STAT will go high. <br> If set to 0 , STAT is always HIZ. |
| 3 | CORD_COMP[1] | 1 | 00: Disable 01: 100mV | Cord Compensation at 2.4A Load with $10 \mathrm{~m} \Omega$ |
| 2 | CORD_COMP[0] | 0 | $\begin{aligned} & \text { 10: } 200 \mathrm{mV} \\ & \text { 11: } 300 \mathrm{mV} \end{aligned}$ | resistor |
| 1 | EN_DLY[1] | 0 | $\begin{array}{\|l\|} \hline 00: 0 \mathrm{~ms} \\ 01: 200 \mathrm{~ms} \end{array}$ | The delay before enabling the converter from the EN pin or EN register bit. |
| 0 | EN_DLY[0] | 0 | $\begin{aligned} & \text { 10: } 500 \mathrm{~ms} \\ & 11: 1 \mathrm{~s} \end{aligned}$ |  |

Solutions for Sustainability

## REG 0x10: Converter Control 3 (R/W) (NVM)

| Bit | Name |  | Comment |
| :---: | :--- | :---: | :--- | :--- |$|$| Description |
| :--- |
| 7 |
| OUTPUT_SLEW[1] |
| OUTPUT_SLEW[0] |
| PULLDOWN_RAMP |

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## REG 0x11: VREG Regulation Voltage 1 (R/W) (NVM)

| Bit | Name |  | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7 | VREG[4] | 1 | 1600 mV | VREG LDO Output Voltage |
| 6 | VREG[3] | 1 | 800 mV | Range: 2V (00000) - 5.1V (11111) |
| 5 | VREG[2] | 1 | 400 mV |  |
| 4 | VREG[1] | 1 | 200 mV |  |
| 3 | VREG[0] | 0 | 100 mV |  |
| 2 | RFU | 1 |  | Reserved for future use. Do not change. |
| 1 | RFU | 1 |  | Reserved for future use. Do not change. |
| 0 | RFU | 0 |  | Reserved for future use. Do not change. |

REG 0x12: RFU (R/W) (NVM)

| Bit | Name |  | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7-0 | RFU | 0xA4h |  | Reserved for future use. Do not change. |

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REG 0x13: Output Voltage 1 (R/W) (NVM)

| Bit | Name | $\begin{aligned} & \frac{0}{\frac{3}{\pi}} \\ & N_{0}^{5} \\ & \frac{1}{7} \\ & \frac{\pi}{0} \end{aligned}$ | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7 | RFU | 1 |  |  |
| 6 | RFU | 0 |  | Reserved for future use. Do not change. |
| 5 | RFU | 1 |  |  |
| 4 | RFU | 0 |  |  |
| 3 | VOUT_I2C | 0 | 0: I2C Register <br> 1: External Resister Divider using IFB | Set to 0 for ACT5101. $1^{2} \mathrm{C}$ registers control the output voltage. <br> Set to 1 for ACT5102. An external voltage divider connected to the FB pin controls the output voltage. |
| 2 | VOUT[9] | 0 | 10240 mV | Internal divider network Offset: 2.96V |
| 1 | VOUT[8] | 0 | 5120 mV | Range: 2.96V (000_0000_0000) to 23.42 V (111 1111 1111) |
| 0 | VOUT[7] | 0 | 2560 mV |  |

REG 0x14: Output Voltage 2 (R/W) (NVM)

| Bit | Name |  | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7 | VOUT[6] | 1 | 1280 mV | Internal divider network <br> Offset: 2.96V <br> Range: 2.96 V (000_0000_0000) to 23.42 V (111_1111_1111) |
| 6 | VOUT[5] | 1 | 640 mV |  |
|  |  |  |  |  |
| 5 | VOUT[4] | 0 | 320 mV |  |
| 4 | VOUT[3] | 1 | 160 mV |  |
| 3 | VOUT[2] | 0 | 80 mV |  |
| 2 | VOUT[1] | 1 | 40 mV |  |
| 1 | VOUT[0] | 1 | 20 mV |  |
| 0 | RFU | 0 |  | Reserved for future use. Do not change. |

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## REG 0x15: RFU (R/W) (NVM)

| Bit | Name |  | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7-0 | RFU | 0x80h |  | Reserved for future use. Do not change. |

REG 0x16: RFU (R/W) (NVM)

| Bit | Name |  | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7-0 | RFU | 0x80h |  | Reserved for future use. Do not change. |

REG 0x17: Output Current Limit (R/W) (NVM)

| Bit |  | Name | Coscription | Comment |
| :---: | :--- | :---: | :---: | :--- |

REG 0x18: RFU (R/W) (NVM)

| Bit | Name | $\begin{aligned} & \frac{0}{5} \\ & \frac{N}{\pi} \\ & \frac{1}{5} \\ & \frac{\pi}{0} \\ & 0 \end{aligned}$ | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7-0 | RFU | 0x64h |  | Reserved for future use. Do not change. |

## REG 0x19: RFU (R/W) (NVM)

| Bit | Name |  | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7-0 | RFU | 0x00h |  | Reserved for future use. Do not change. |

REG 0x1A: VIN UV OFFSET (R/W) (NVM)

| Bit | Name |  | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7 | RFU | 0 |  | Reserved for future use. Do not change. |
| 6 | VIN_UV_OFFSET[6] | 0 | 6400 mV | Input UV offset voltage. |
| 5 | VIN_UV_OFFSET[5] | 0 | 3200 mV | Range: 5V (0000000) ~ 15.2V (1111111) |
| 4 | VIN_UV_OFFSET[4] | 0 | 1600 mV |  |
| 3 | VIN_UV_OFFSET[3] | 0 | 800 mV |  |
| 2 | VIN_UV_OFFSET[2] | 0 | 400 mV |  |
| 1 | VIN_UV_OFFSET[1] | 0 | 200 mV |  |
| 0 | VIN_UV_OFFSET[0] | 0 | 100 mV |  |

REG 0x1B: RFU (R/W) (NVM)

| Bit | Name |  | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7-0 | RFU | 0x40h |  | Reserved for future use. Do not change. |

## REG 0x1C: RFU (R/W) (NVM)

| Bit | Name |  | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7-0 | RFU | 0x40h |  | Reserved for future use. Do not change. |

REG 0x1D: Frequency Setting (R/W) (NVM)

| Bit | Name |  | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7 | FREQ_SEL[1] | 1 | Frequency Selection Settings for SMPS <br> 00: 125 kHz <br> 01: 250kHz | Operation Frequency Settings <br> Note: These can NOT be changed "on the fly" and each setting requires a different inductor value and capacitors and compensation components. |
| 6 | FREQ_SEL[0] | 0 | 10: 500 kHz <br> 11: 1 MHz | CARE SHOULD BE TAKEN WHEN WRITING TO THIS REGISTER TO AVOID CHANGING THE FREQUENCY WHILE OPERATING |
| 5 | RFU | 0 |  | Reserved for future use. Do not change. |
| 4 | RFU | 0 |  | Reserved for future use. Do not change. |
| 3 | RFU | 0 |  | Reserved for future use. Do not change. |
| 2 | RFU | 0 |  | Reserved for future use. Do not change. |
| 1 | TREG[1] | 1 | $\begin{aligned} & \text { 00: Disable } \\ & 01: 0^{\circ} \mathrm{C} \end{aligned}$ | Die temperature regulation threshold |
| 0 | TREG[0] | 1 | $\begin{aligned} & 10: 100^{\circ} \mathrm{C} \\ & 11: 120^{\circ} \mathrm{C} \end{aligned}$ |  |

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## REG 0x1E: IRQ Control 1 R/W (VM)

| Bit | Name | $\begin{aligned} & \frac{0}{5} \\ & \frac{10}{\pi} \\ & \frac{\pi}{3} \\ & \frac{\pi}{0} \\ & 0 \end{aligned}$ | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7 | RFU | 0 |  | Reserved for future use. Do not change. |
| 6 | RFU | 0 |  | Reserved for future use. Do not change. |
| 5 | RFU | 0 |  | Reserved for future use. Do not change. |
| 4 | nIRQ_VIN_UVOV | 0 | 0: VIN UV or OV on nIRQ <br> 1: Masks nIRQ | If set to 0 , an input voltage UV or OV condition activates the nIRQ Pin <br> Setting to 1 , masks the fault to nIRQ |
| 3 | RFU | 0 |  | Reserved for future use. Do not change. |
| 2 | RFU | 0 |  | Reserved for future use. Do not change. |
| 1 | nIRQ_VREG_FLT | 0 | 0: VREG LDO <br> Overcurrent or Undervoltage indicated on nIRQ <br> 1: Masks nIRQ | If set to 0 , a VREG LDO Overcurrent or Undervoltage activates the nIRQ pin Setting to 1 , masks the fault to nIRQ |
| 0 | $n I R Q \_T S D$ | 0 | 0: Device Thermal Shutdown indicated on nIRQ <br> 1: Masks nIRQ | If set to 0 , a device Thermal Shutdown activates the $\operatorname{nIRQ}$ pin <br> Setting to 1 , masks the fault to nIRQ |

## REG 0x1F: IRQ Control 2 R/W (VM)

| Bit | Name |  | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7 | nIRQ_FET_OC | 0 | 0 : FET Overcurrent triggers nIRQ pin <br> 1: Masks nIRQ | If set to 0 , a FET Overcurrent condition activates the nIRQ pin <br> Setting to 1 , masks CHG done states to nIRQ |
| 6 | nIRQ_Watchdog | 0 | 0: Watchdog timer expired triggers nIRQ <br> 1: Masks nIRQ | If set to 0 , a watchdog timeout activates the nIRQ pin <br> Setting to 1 , masks the fault nIRQ |
| 5 | nIRQ_HICCUP | 0 | 0: Converter is in Hiccup state $\operatorname{nIRQ}$ <br> 1: Masks nIRQ | If set to 0 , converter entering Hiccup state activates the nIRQ pin <br> Setting to 1, masks hiccup mode to nIRQ |
| 4 | $n I R Q \quad L L$ | 0 | 0: Converter Light Load state on nIRQ <br> 1: Masks nIRQ | If set to 0 , converter entering Light Load Disable state activates the nIRQ pin <br> Setting to 1, masks light load disable state to nIRQ |
| 3 | nIRQ_A2D_DATA | 0 | 0: A2D Data Ready <br> 1: Masks A2D Data Ready nIRQ | If set to 0 , a rising edge on A2D Data Ready activates the $\operatorname{nIRQ}$ pin <br> Setting to 1, masks the A2D Data Ready to nIRQ |
| 2 | nIRQ_HIZ | 0 | 0: Enter HIZ Mode <br> 1: Masks Enter HIZ Mode nIRQ | If set to 0 , a rising edge when entering HIZ State activates the $\operatorname{nIRQ}$ pin <br> Setting to 1, masks the HIZ Enter to nIRQ |
| 1 | RFU | 0 |  | Reserved for future use. Do not change. |
| 0 | RFU | 0 |  | Reserved for future use. Do not change. |

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## REG 0x20: IRQ / Status (R/W) (VM)

| Bit | Name |  | Description | Comment |
| :---: | :---: | :---: | :---: | :---: |
| 7 | nIRQ_I2C_ERROR | 0 | 0: I2C Fault <br> 1: Masks I2C Fault nIRQ | If set to 0 , a fault on the I2C command / I2C bus activates the nIRQ Pin <br> Setting to 1 , masks the nIRQ |
| 6 | INPUT_CC | 0 | 0 : Input not in current limit <br> 1: Input is regulating in Constant Current Mode | Real Time status <br> This is the current measured on the VIN side using ISRP and ISRN and is controlled by the VIN_ILIM Register |
| 5 | OUTPUT_CC | 0 | 0 : Output regulating using voltage loop <br> 1: output is regulating in Constant Current Mode | Real Time status <br> This is the current measured on the VOUT side using OSRP and OSRN and is controlled by the CC Register |
| 4 | VIN_UV | 0 | 0: VIN above VIN_UV <br> 1: VIN below VIN_UV | Real time status - For latched fault, see the Fault Registers |
| 3 | VIN_OV | 0 | NA | 0: VIN below OV <br> 1: VIN above OV |
| 2 | STATUS[2] | 0 | $\begin{aligned} & \text { 00: RST } \\ & \text { 001: SS } \end{aligned}$ | State machine for POWER ON state 101-111: Not Valid |
| 1 | STATUS[1] | 0 | 010: REG |  |
| 0 | STATUS[0] | 0 | 011: HICCUP 100: LL_DIS |  |

## PACKAGE OUTLINE AND DIMENSIONS QFN4X4-32



IDP VIEW


| Dimensional Ref. |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
| REF. | Min. | Nom. | Max. |  |
| A | 0.800 | 0.850 | 0.900 |  |
| A1 | --- | --- | 0.050 |  |
| A3 | 0.203 Ref. |  |  |  |
| D | 3.950 | 4.000 | 4.050 |  |
| E | 3.950 | 4.000 | 4.050 |  |
| D2 | 1.550 | 1.600 | 1.650 |  |
| E2 | 0.950 | 1.000 | 1.050 |  |
|  | -- |  |  |  |
| b | 0.150 | 0.200 | 0.250 |  |
| e | 0.400 BSC |  |  |  |
| L1 | 0.350 | 0.400 | 0.450 |  |
| L2 | 0.750 | 0.800 | 0.850 |  |
| Tol. of Form\&Position |  |  |  |  |
| aaa | 0.10 |  |  |  |
| bbb | 0.10 |  |  |  |
| ccc | 0.10 |  |  |  |
| ddd | 0.05 |  |  |  |
| eee | 0.08 |  |  |  |
| fff | 0.10 |  |  |  |

All dimensions are in millimeters
Dimensioning and tolerancing per JEDED MO-232
See Active Semi Application note AN-104, QFN PCB Layout Guidelines for more information on generating the ACT5101 land pattern.


Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits,General Dynamics и др.);

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- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.


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